

ARMPAC-6XXB Series

7"/10.1" Plastic Chassis Fanless Broadcom BCM2711, Quad core Cortex-A72 HMI

User Manual

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15F-1, No.186, Jian Yi Road, Zhonghe District, New Taipei City 235, Taiwan

Tel: 886-2-82262881 Fax: 886-2-82262883 URL: <http://www.aplextec.com/zh/home.php>

Revision History

Reversion	Date	Description
1.0	2023/03/13	Official Version

Warning!

This equipment generates, uses and can radiate radio frequency energy and if not installed and used in accordance with the instructions manual, it may cause interference to radio communications. It has been tested and found to comply with the limits for a Class A computing device pursuant to FCC Rules, which are designed to provide reasonable protection against such interference when operated in a commercial environment. Operation of this equipment in a residential area is likely to cause interference in which case the user at his own expense will be required to take whatever measures may be required to correct the interference.

Electric Shock Hazard – Do not operate the machine with its back cover removed. There are dangerous high voltages inside.

Caution

Risk of explosion if the battery is replaced with an incorrect type.

Batteries should be recycled where possible. Disposal of used batteries must be in accordance with local environmental regulations.

Disclaimer

This information in this document is subject to change without notice. In no event shall Apex Technology Inc. be liable for damages of any kind, whether incidental or consequential, arising from either the use or misuse of information in this document or in any related materials.

Packing List

Accessories (as ticked) included in this package are:
<input type="checkbox"/> Adaptor
<input type="checkbox"/> Driver & manual CD disc
<input type="checkbox"/> Other. _____ (please specify)

Safety Precautions

Follow the messages below to prevent your systems from damage:

- ◆ Avoid your system from static electricity on all occasions.
- ◆ Prevent electric shock. Don't touch any components of this card when the card is power-on. Always disconnect power when the system is not in use.
- ◆ Disconnect power when you change any hardware devices. For instance, when you connect a jumper or install any cards, a surge of power may damage the electronic components or the whole system.

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Chapter 1

Getting Started

1.1 Features

- ARM based HMI
- Fanless design
- Flat front panel touch screen
- Raspberry Pi Computer Module 4, Quad Core Cortex-A72 Processor
- Onboard 4GB LPDDR4 DRAM
- Onboard 16GB/32GB eMMC Flash
- DC 24V power input w/ 3KV isolation

1.2 Specifications

	ARMPAC-607B(P)	ARMPAC-610B(P)
System		
CPU	Broadcom BCM2711, Quad core Cortex-A72 (ARM v8) 64-bit SoC @ 1.5GHz	
Memory	Onboard 4GB LPDDR4 DRAM	
External IO Port		
USB	1 x USB 2.0 via Vertical USB type-A connector (Master) 1 x USB download via micro USB (Slave only)	
Serial/Parallel	1 x Pitch 3.5mm 2x5pin Terminal Block(COM1_2) with: 1 x RS232(RX, TX, RTS, CTS)/2W RS485(D+, D-) (COM1), select via jumper 1 x RS232(RX, TX, RTS, CTS) (COM2)	
LAN	1 x GbE LAN, RJ45	
Power	DC24V±10% power input, w/3kV Isolation	
Option	Onboard Wifi/BT module 2.4GHz, 5.0 GHz IEEE 802.11 b/g/n/ac wireless Bluetooth 5.0, BLE	
RTC Battery		
RTC Battery	CR2032	
Switch		
Switch	2x2Pin Switch for Burning Mode & Boot Device Select (eMMC/USB Boot Mode)	
LED Indicator		
LED Indicator	1xPower LED	
Storage Space		
Storage	Onboard 16GB/32GB eMMC Flash	

	1 x Micro SD Slot	
Expansion		
Expansion Slot	1 x Mini-PCIe Slot full size for optional 4G module(EC25, w/SIM slot series) 1 x 2x8Pin Header for TB-508 series (2xUART[RX,TX],I2C,USB2.0[Via 1 to 4 USB2.0 Hub],3.3V,5V) 1 x Micro SIM slot for mPCIe	
Display		
Display Type	7" color TFT LVDS LCD	10.1" color TFT LCD
Resolution	800x480	1280x800
Max. Color	262K	TBD
Luminance	400	350
Contrast Ratio	400: 1	800: 1
Viewing Angle	140(H)/140(V)	170(H)/170(V)
Backlight Lifetime	20,000 hrs	30,000 hrs
Touch Screen – Projected Capacitive Type		
Interface	USB	
Light Transmission	88±2%	
Power		
Power Input	DC24V±10% power input, w/3kV Isolation	
Power Consumption	MAX: 7.7W (607B)	MAX: 15.4W (610B)
Mechanical		
Front Bezel Metal	Plastic/Panel Mount	
Rear Panel Metal	Plastic/VESA 75	Plastic/VESA 75
Chassis Color	Black C	
IP Rating	IP65 Front Panel	
Dimensions(mm)	204 x 150 x 46	269 x 189 x 49.5
Net Weight (Kg)	0.7	0.9
Environmental		
Operating Temperature	0~50°C (-20~60°C option)	
Storage Temperature	-30~70°C	
Humidity	10 to 90% @ 40°C, non-condensing	
Certification	CE / FCC Class A	
Operating System	Yocto Linux Kernal 5.x w/Chromium Browser ANDROID 10 above (Default)	

1.3 Dimensions

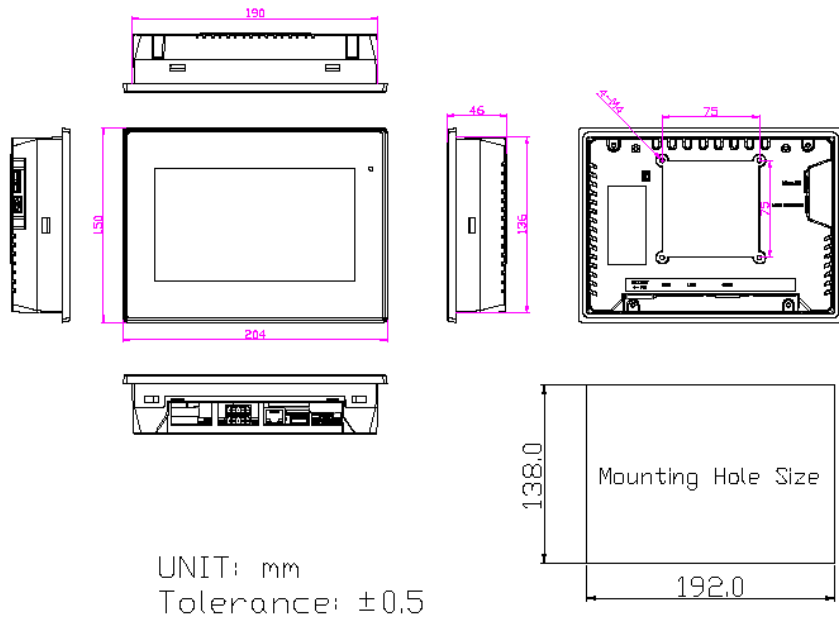


Figure 1.1: Dimensions of ARMPAC-607B(P)

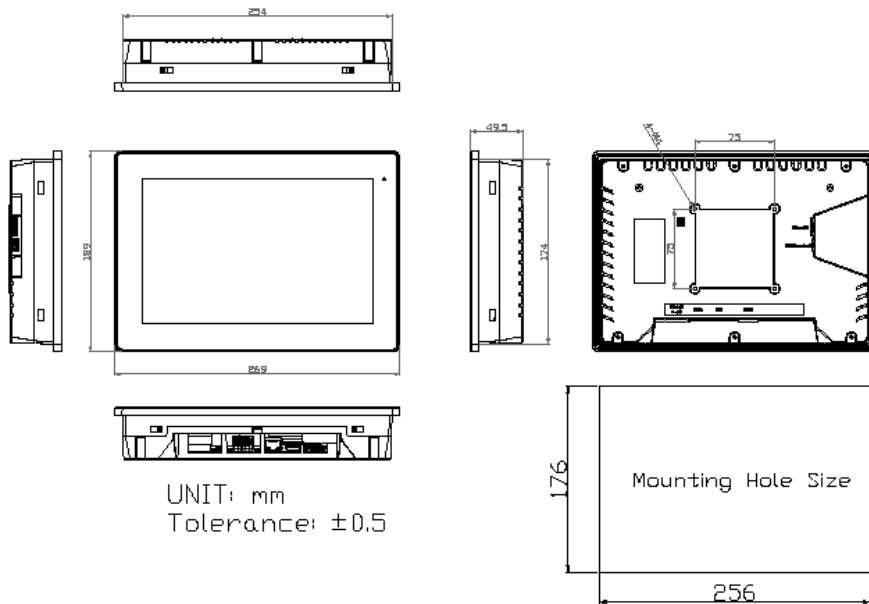


Figure 1.2: Dimensions of ARMPAC-610(P)

1.4 Brief Description of ARMPAC-6XXB

ARMPAC-6B series have 7", and 10.1" in fanless designed ARM based HMI, which comes with flat front panel LED backlight touch designed. They are powered by Broadcom BCM2711 ARM Quad core Cortex-A72 processor, 4GB DDR3 onboard memory, and 16GB eMMC or 32GB eMMC NAND flash onboard. ARMPAC-6XXB series is DC 24V power input and IP66 compliant front panel. The 7", and 10.1" model can be VESA 75 x 75 mounted. The chassis color is Black C for plastic design in 7" and 10.1". Default projected capacitive touch screen supports 7H anti-scratch surface is ideal for use as PC-based controller for industrial automation & factory automation.

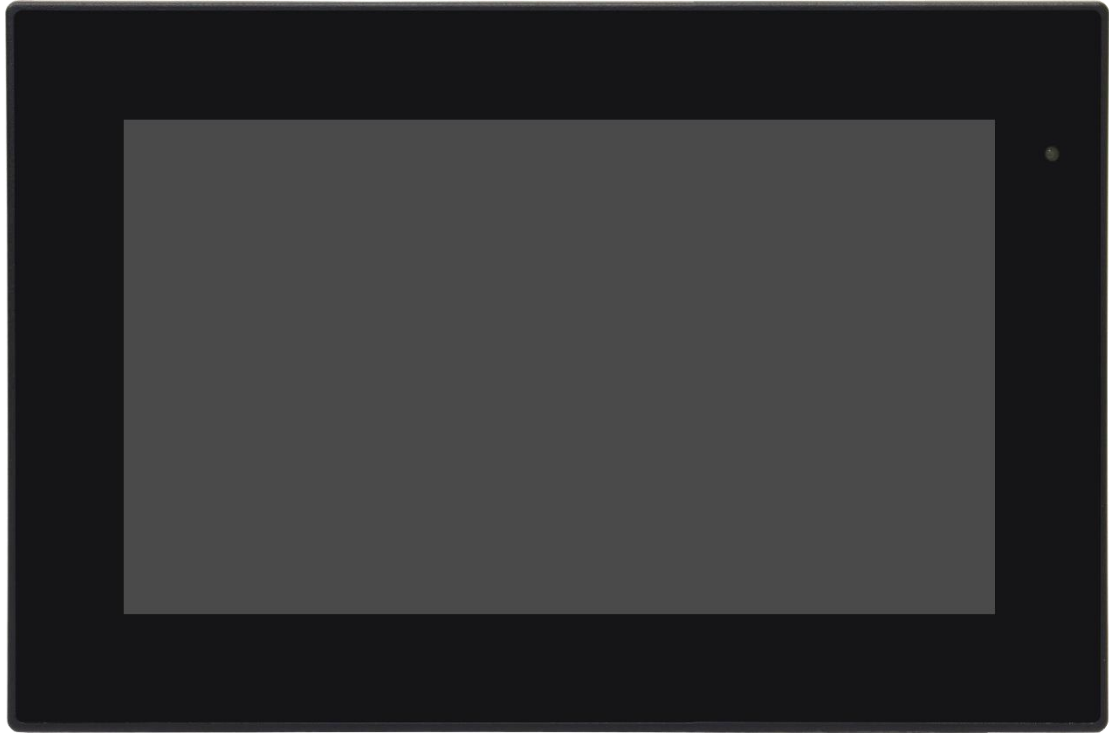


Figure 1.3: Front View of ARMPAC-6XXB Series



Figure 1.4: Rear View of ARMPAC-6XXB Series

1.5 VESA Mounting

The ARMPAC-6XXB series is designed to be VESA mounted as shown in Picture. Just carefully place the unit through the hole and tighten the given screws from the rear to secure the mounting.

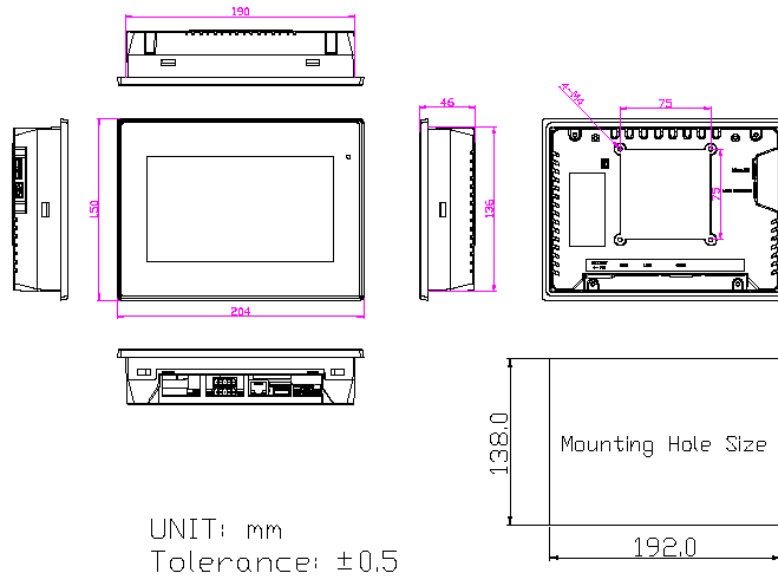
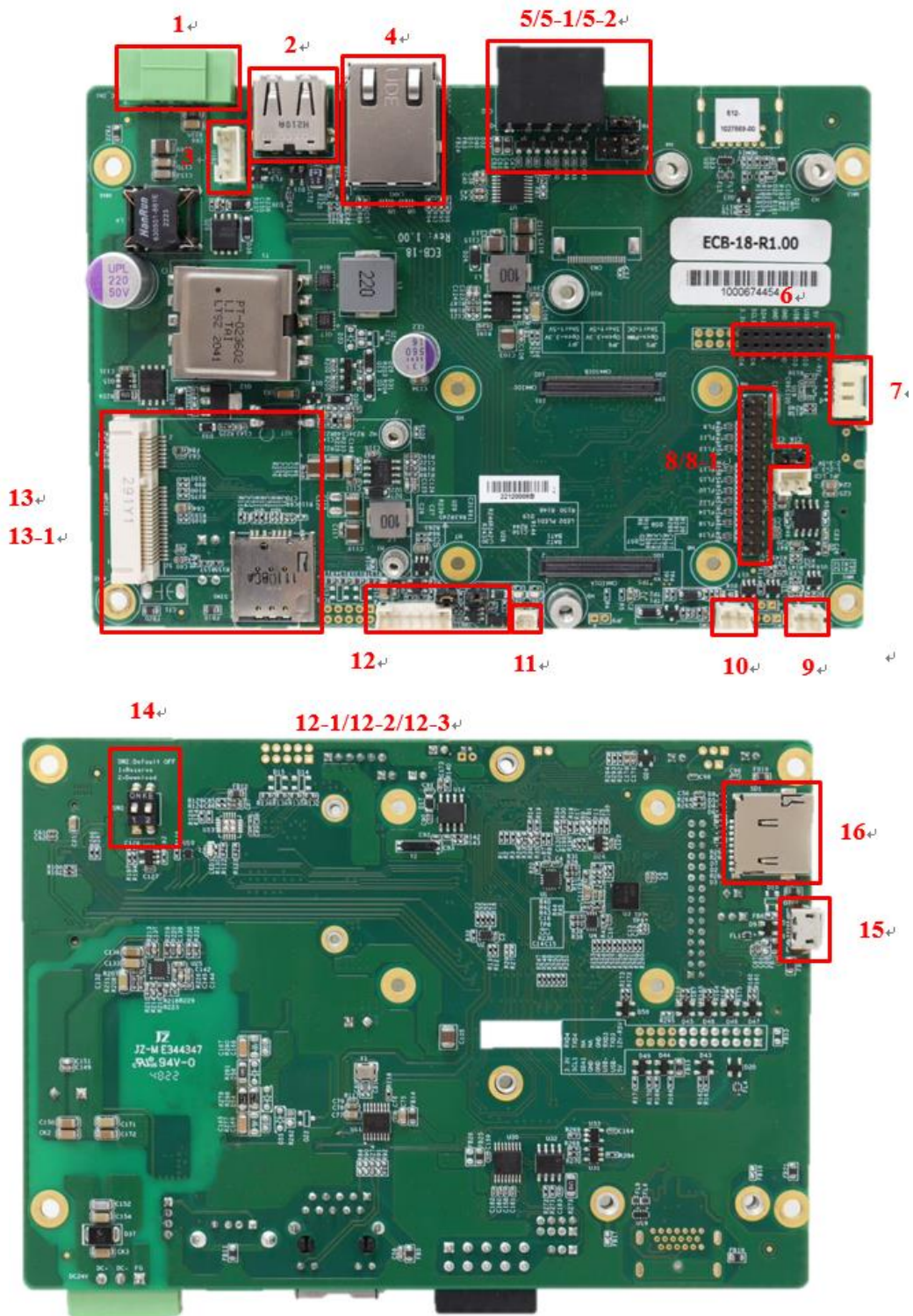


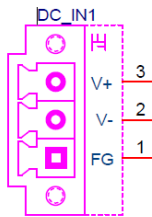
Figure 1.5: ARMPAC-6XXB Series VESA Mounting

2.1 Motherboard Jumpers Setting and Connectors



1. DC_IN1:

(3.50mm Pitch 1x3 Pin Connector), For DC 24V system power input.



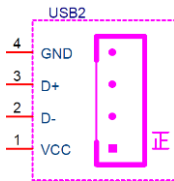
Pin#	Signals
1	FG
2	DC_IN-
3	DC_IN+

2. USB1:

(USB type A Port), Front USB connector, it provides a USB2.0 port, High-speed USB 2.0 allows data transfers up to 480 Mb/s, support USB full-speed and low-speed signaling.

3. USB2:

(2.0mm Pitch 1x4 Pin Wafer Header), It provides an internal USB2.0 port, High-speed USB 2.0 allows data transfers up to 480 Mb/s, support USB full-speed and low-speed signaling.



Pin#	Signals
1	5V_VCC
2	D-
3	D+
4	GND

4. LAN1:

(RJ45 Connector), Front LAN port. It provides a standard GbE RJ45 Ethernet port.

RJ45 LED Status

	Speed(LED1)	Link/Activity(LED2)
10	Off	Yellow Blinking
100	Yellow Solid	
GbE	Yellow Blinking	

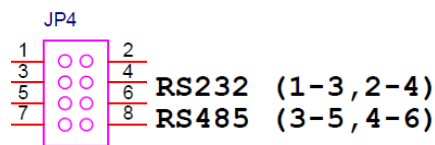
5. CN2:

(3.50mm Pitch 2x5 Pin Terminal Block), Provides 2xCOM, including 1x4-wired RS232/2-wired RS485 and 1x4-wired RS232.

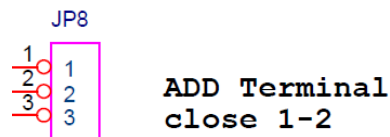


Pin#	COM1(RS232)	COM1(RS485)	COM2(RS485/CAN)
1	GND		GND
2			
3	CTS		CAN_H
4			
5	RTS		CAN_L
6			
7	TX		485-
8			485-
9	RX		485+
10			485+

5-1. JP4 (2x4 Pin Jumper), For 4-wired RS232/2-wired RS485 select.



5-2. JP8 (1x3 Pin Jumper), For RS485 add terminal.



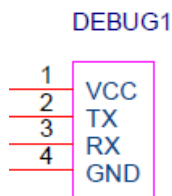
6. CON1

(2.00mm Pitch 2x8 Female Header), Connector for TB-508 series I/O expansion boards.

Signals	Pin#	Pin#	Signals
5V_VCC	1	2	12V_VCC
USB_D-	3	4	UART3_TXD
USB_D+	5	6	UART3_RXD

GND	7	8	GND
GND	9	10	
SDA1	11	12	
SCL1	13	14	UART4_TXD
3.3V_VCC	15	16	UART4_RXD

7. DEBUG1



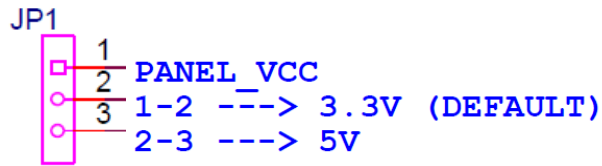
Pin#	Signals
1	3.3V_VCC
2	UART0_TX
3	UART0_RX
4	GND

8.CN1 :

(2.00mm Pitch 2x15 Pin Male Header), Provides 18/24bits dual channel LVDS, support up to 1920x1080@60fps.

Signals	Pin#	Pin#	Signals
LCD_VCC (3.3V/5V select via JP1)	1	2	LCD_VCC (3.3V/5V select via JP1)
LCD_VCC (3.3V/5V select via JP1)	3	4	GND
GND	5	6	GND
TXA0-	7	8	TXA0+
TXA1-	9	10	TXA1+
TXA2-	11	12	TXA2+
GND	13	14	GND
TXAC-	15	16	TXAC+
TXA3-	17	18	TXA3+
TXB0-	19	20	TXB0+
TXB1-	21	22	TXB1+
TXB2-	23	24	TXB2+
GND	25	26	GND
TXBC-	27	28	TXBC+
TXB3-	29	30	TXB3+

8-1. JP1 (1x3 Pin Jumper), For LVDS VCC 3.3V/5V select.



9. CN4

(2.00mm Pitch 1x2 Pin Wafer Header), For power LED.

Pin#	Signals
1	PWR_LED
2	GND

10. PSW1

(2.00mm Pitch 1x2 Pin Wafer Header), For external power switch.

Pin#	Signals
1	Power ON/OFF
2	GND

11. BAT1/2 (Co-lay)

(2.00mm Pitch 1x2 Pin Wafer Header/1.25mm Pitch 1x2 Pin Wafer Header **Default**)

For RTC battery.

Pin#	Signals
1	VRTC_R
2	GND

12. INVT1:

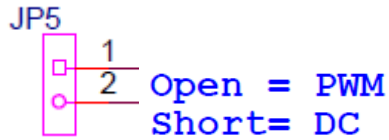
(2.0mm Pitch 1*6 box Pin Header), Backlight power & control.



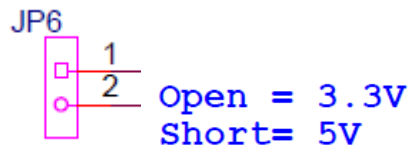
Pin#	Signals
1	12V_VCC
2	12V_VCC
3	GND
4	GND

5	BKLT_EN
6	BKLT_CTRL

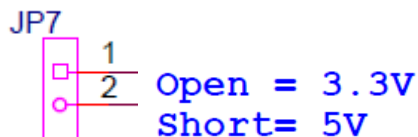
12-1. JP5 (1x3 Pin Jumper), For LCM backlight control mode select.



12-2. JP6 (1x3 Pin Jumper), For LCM backlight control 3.3/5V select.



12-3. JP7 (1x3 Pin Jumper), For LCM backlight enable 3.3/5V select.



13. MPCIE

Standard mini PCIe socket with 1xMicro SIM slot (13-1). Support full-sized expansion cards.

14. SW2

For boot mode select (eMMC/OTG device).



15. OTG1

Micro-USB connector for USB download mode.

16. SD1

Micor SD slot support up to 32GB.

Chapter 3

Software images

3.1 Update Linux for ARMPAC-607BP/610BP

1. To upgrade the Yocto Linux firmware, you must have three files as below and prepare a 16 GB above USB flash disk for installation.

File 1: win32diskimager-1.0.0-install.exe

Make USB boot image disk tool.

File 2: 607B_usb_flashos.img or 610B_usb_flashos.img

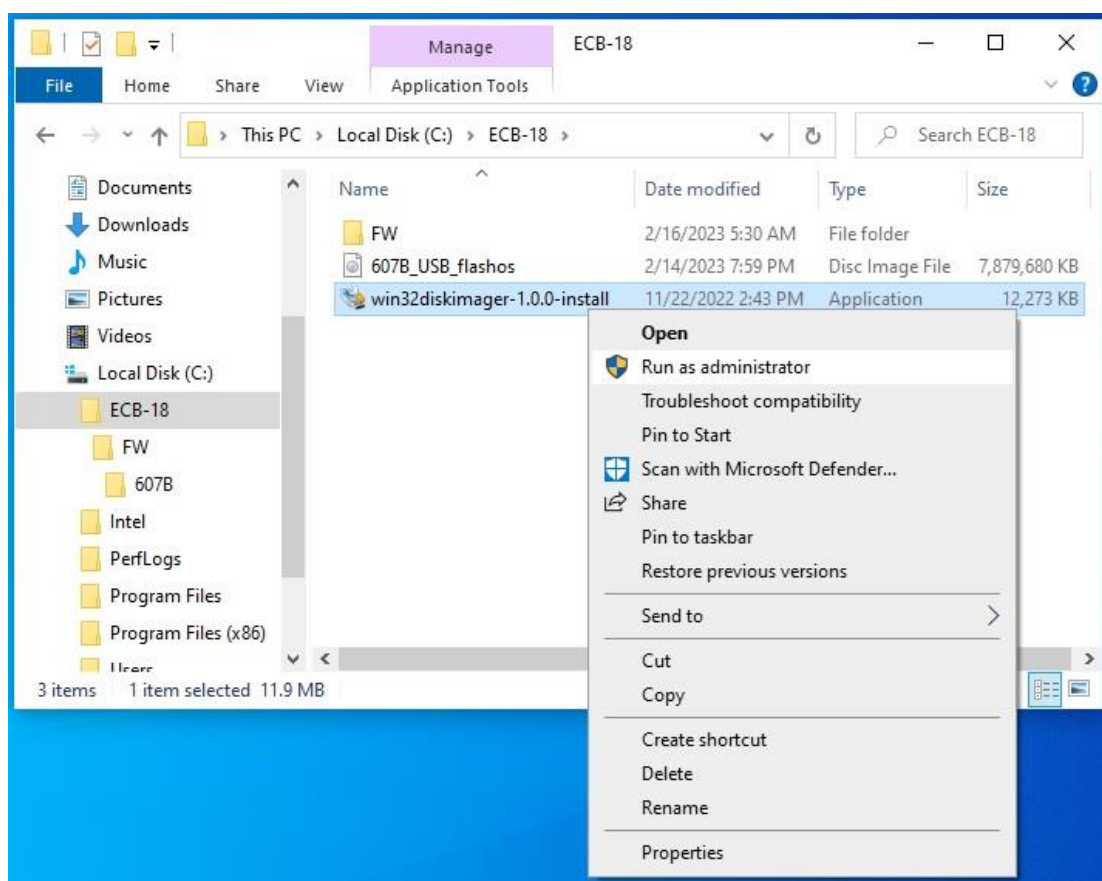
Bootable USB flash disk image file (Linux).

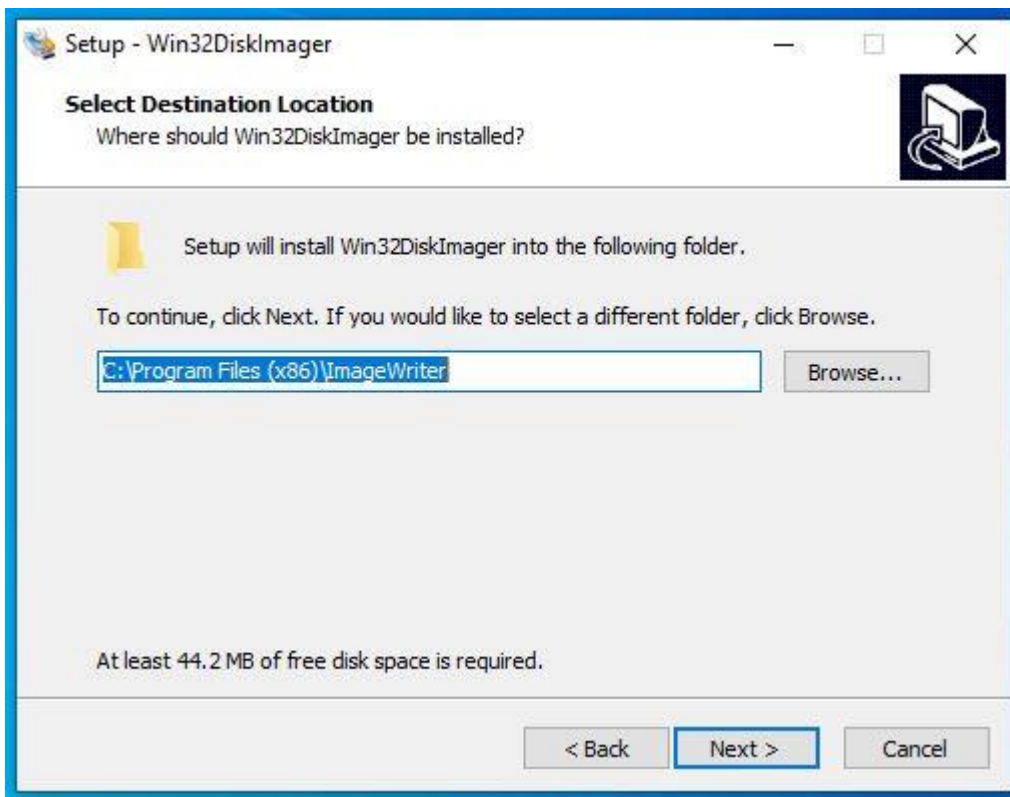
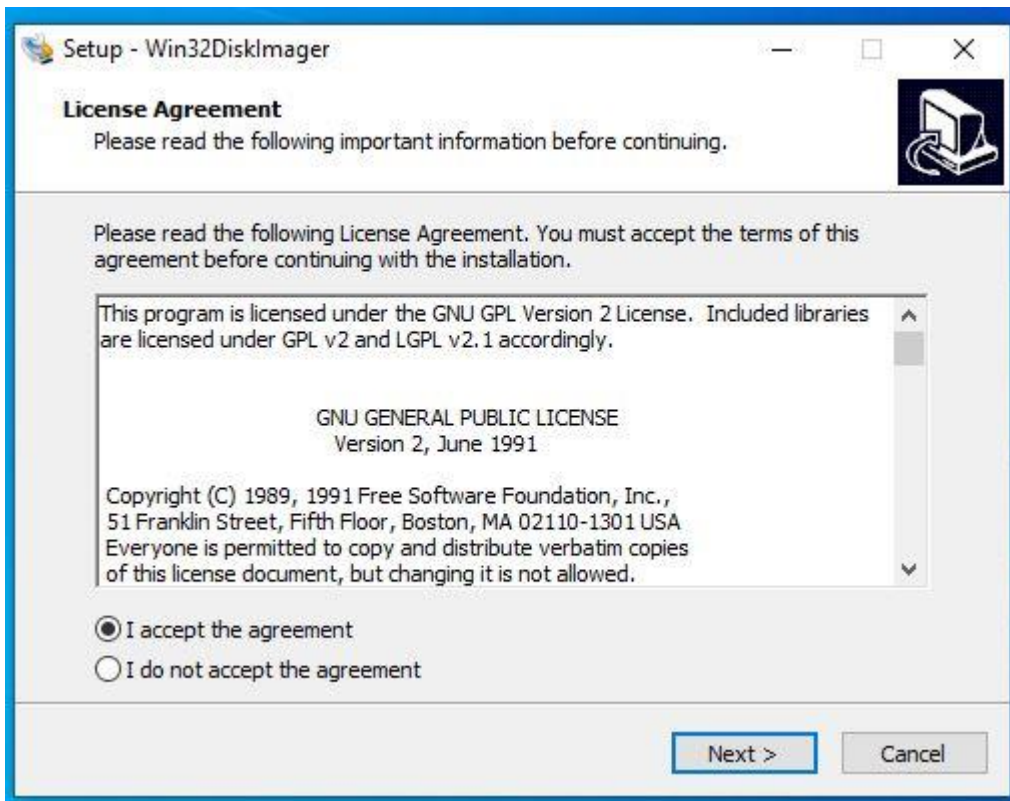
File 3: core-image-base-raspberrypi4-64.img

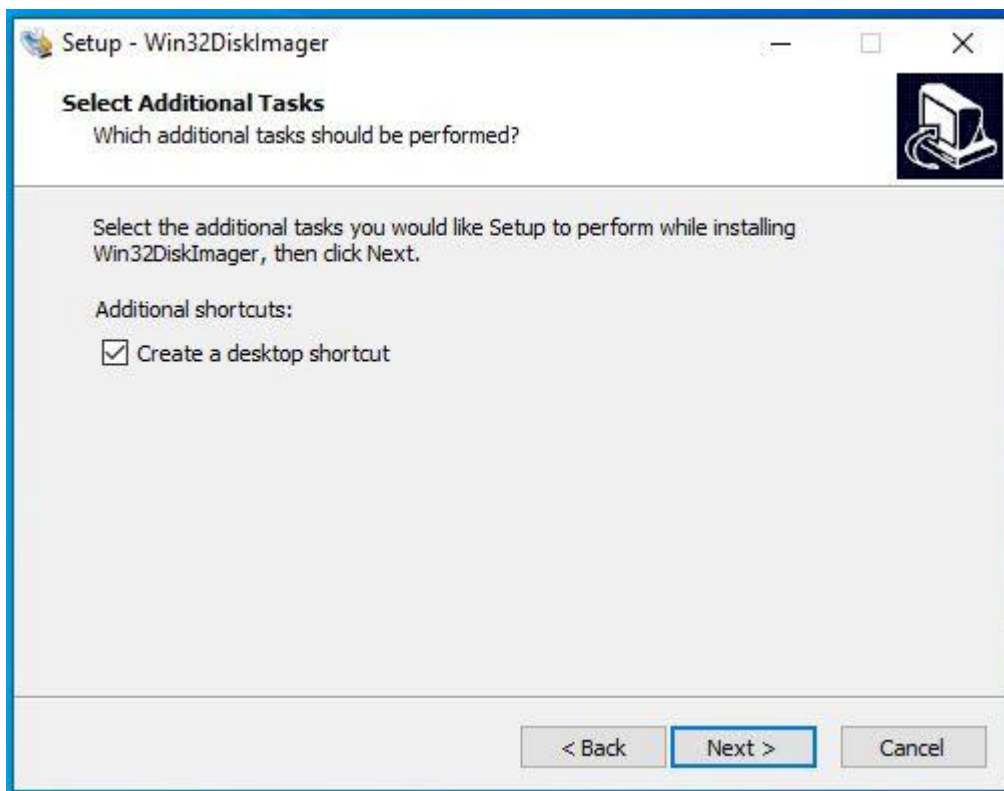
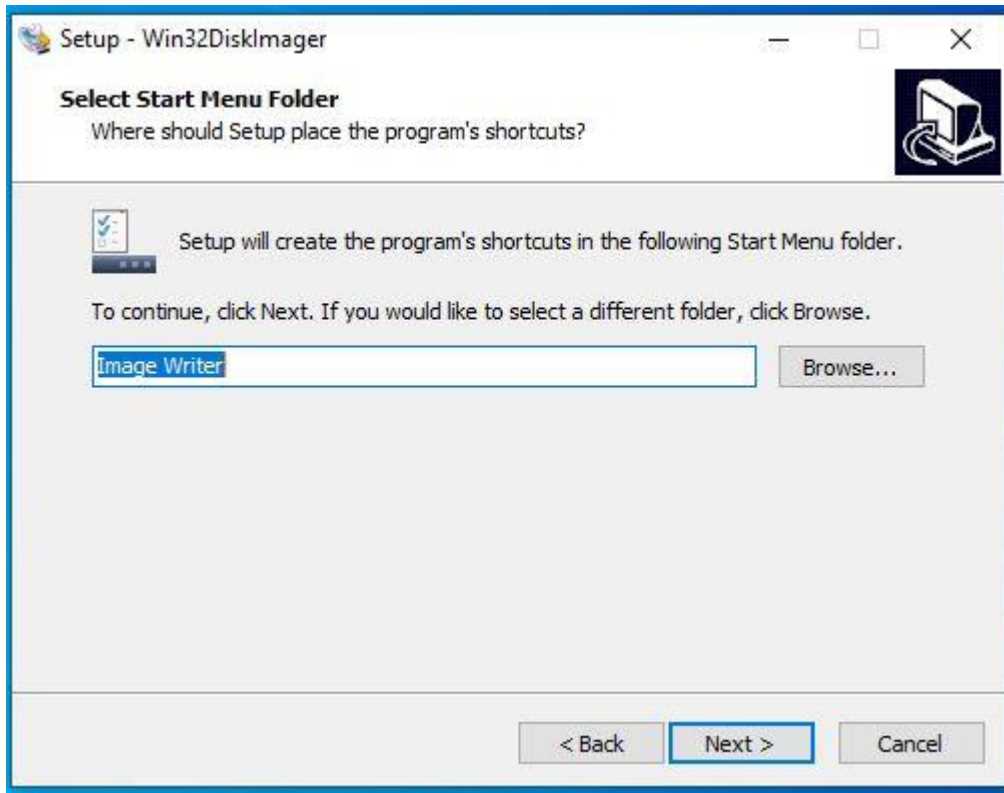
Yocto Linux FW image file (607B and 610B are different).

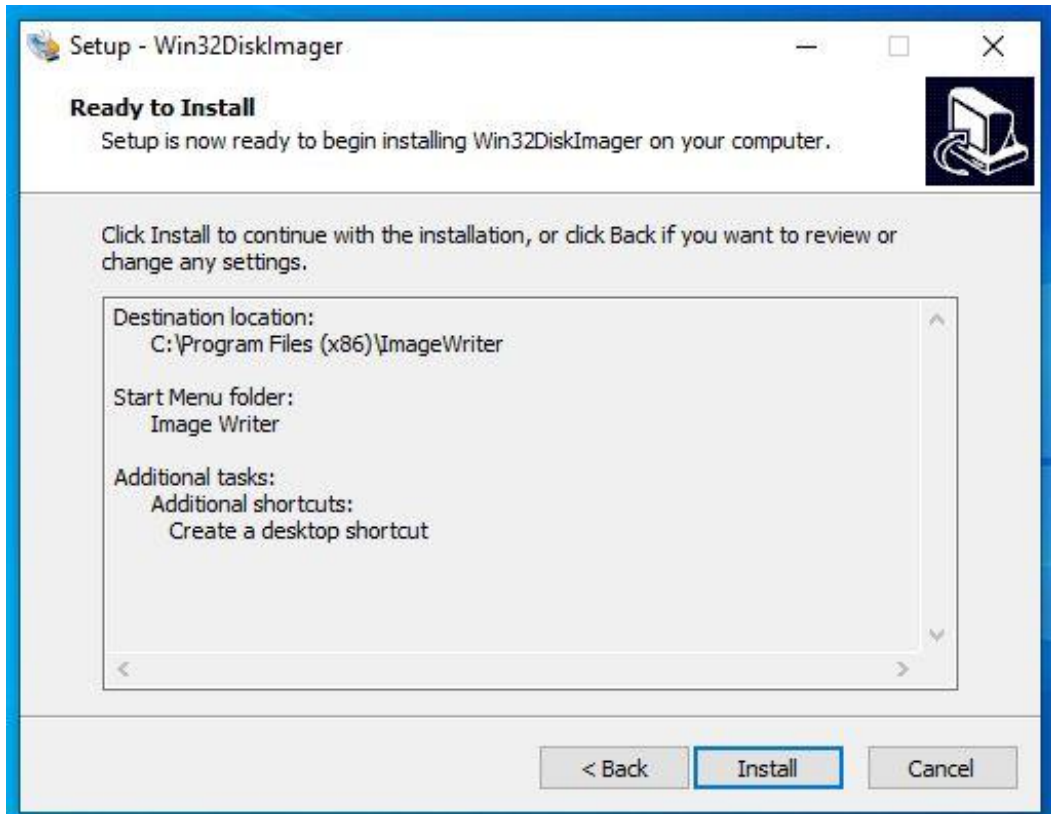
Step 1. → File1: win32diskimager-1.0.0-install.exe.

- 1) Install [win32diskimager-1.0.0-install.exe](#)



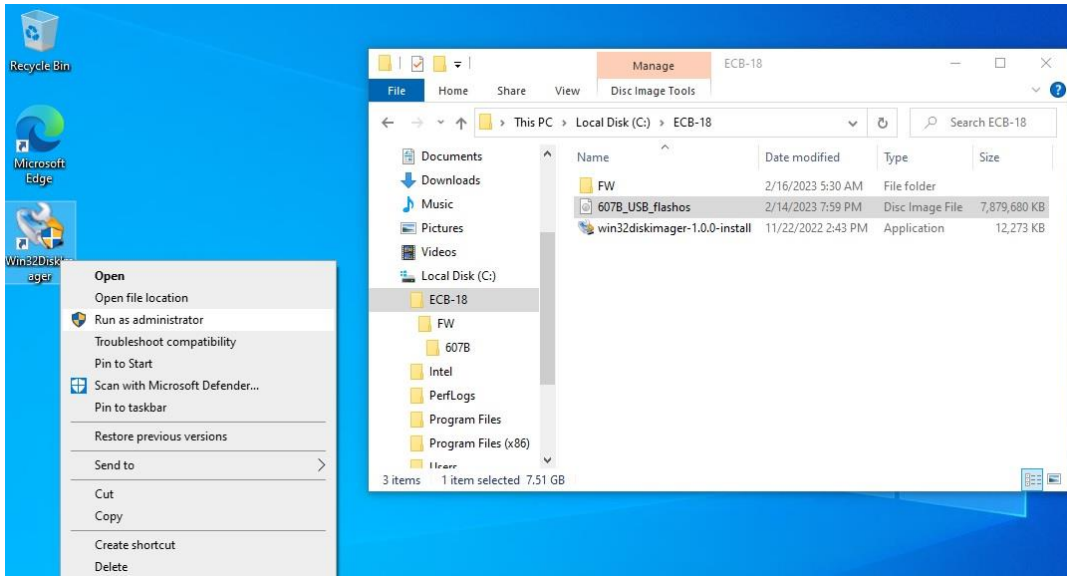




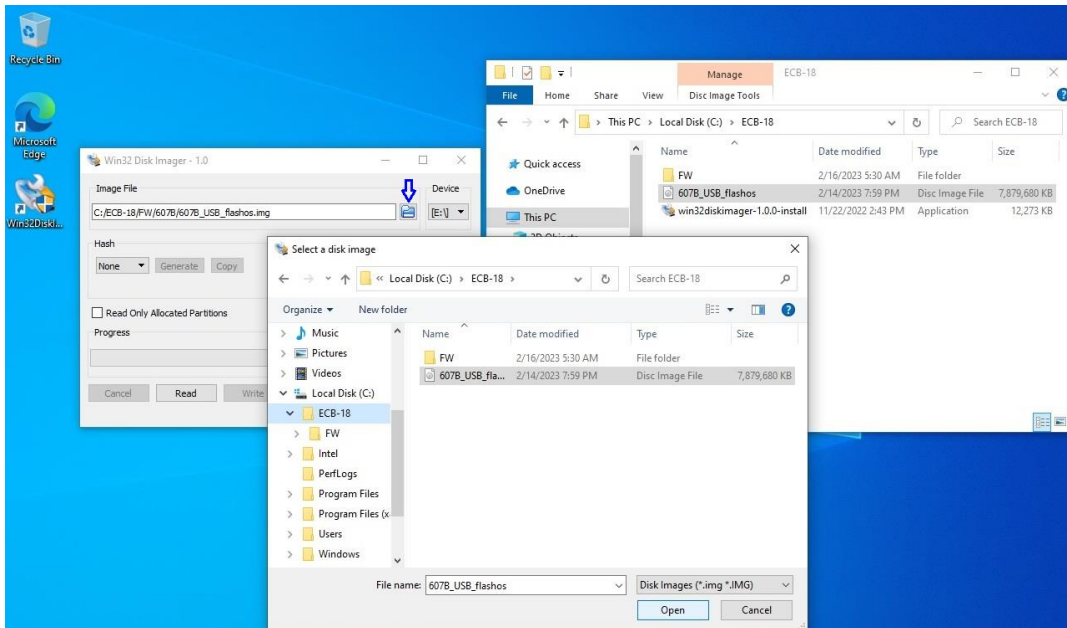


Step 2. → File2: **607B_usb_flashos.img** or **610B_usb_flagsos.img**

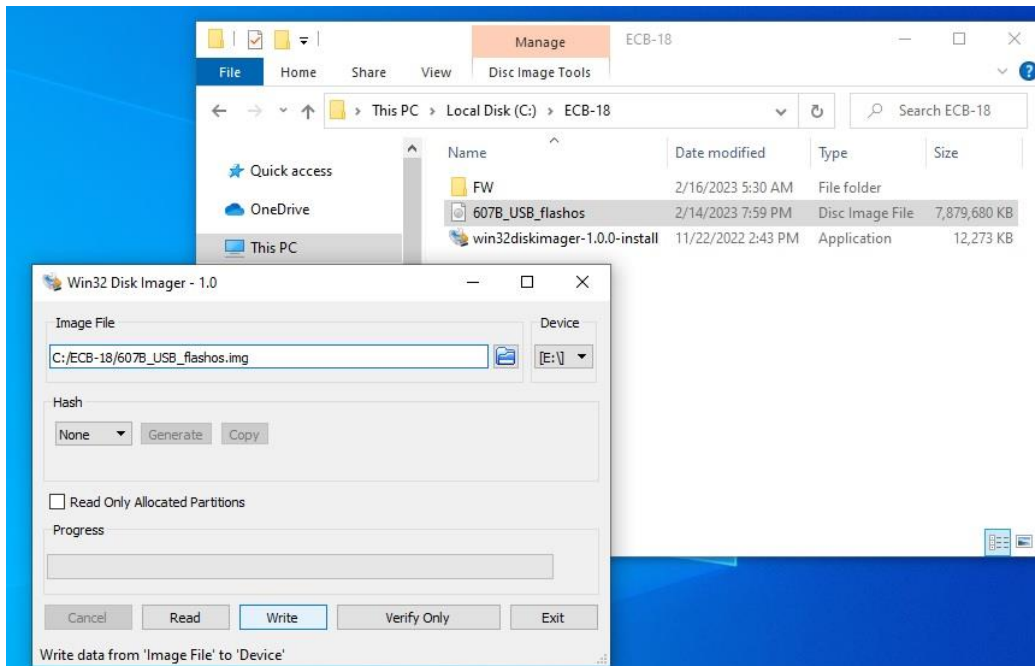
1) Run “Win32diskimager” APP to make Linux USB boot disk.



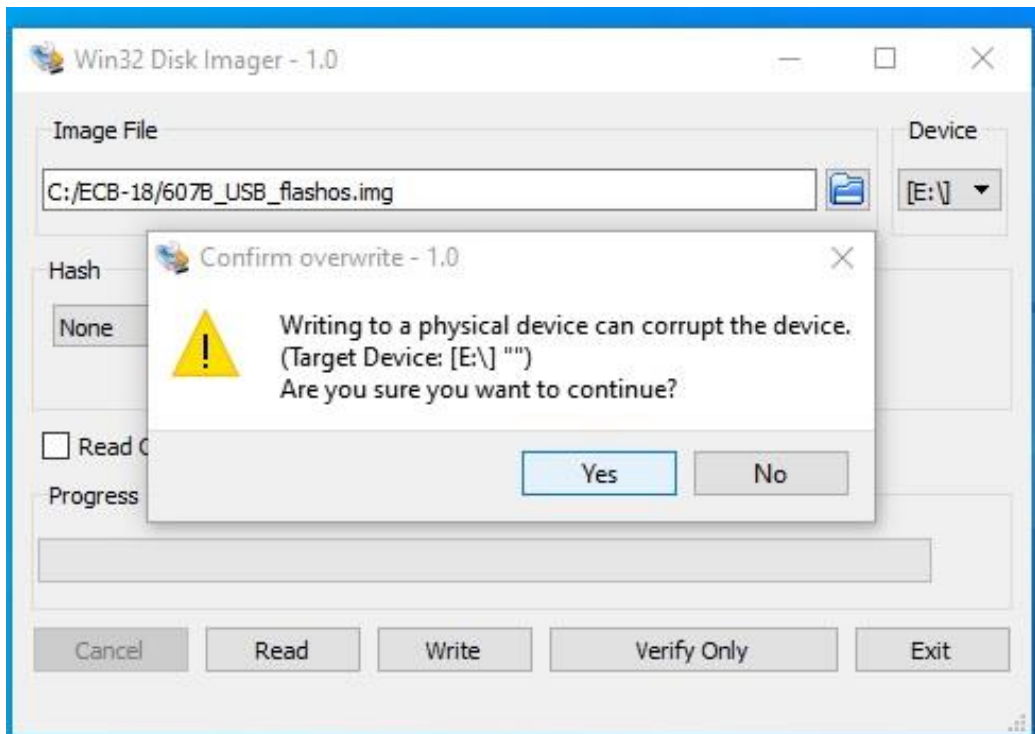
2) Select source file: **607B_usb_flashos.img** or **610B_usb_flagsos.img**

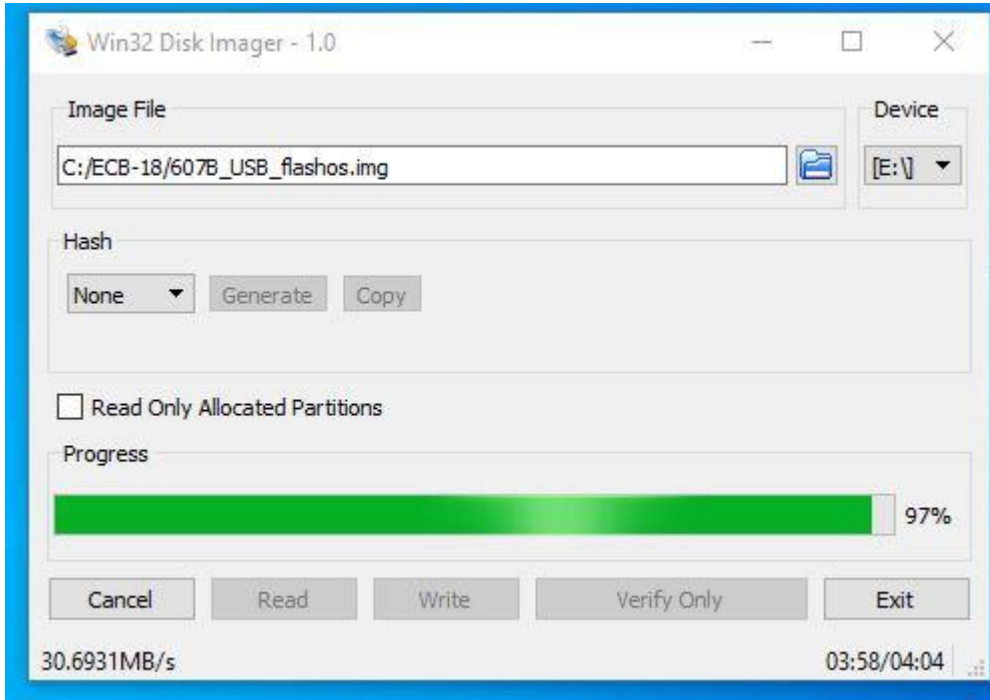


3) Select “Write”

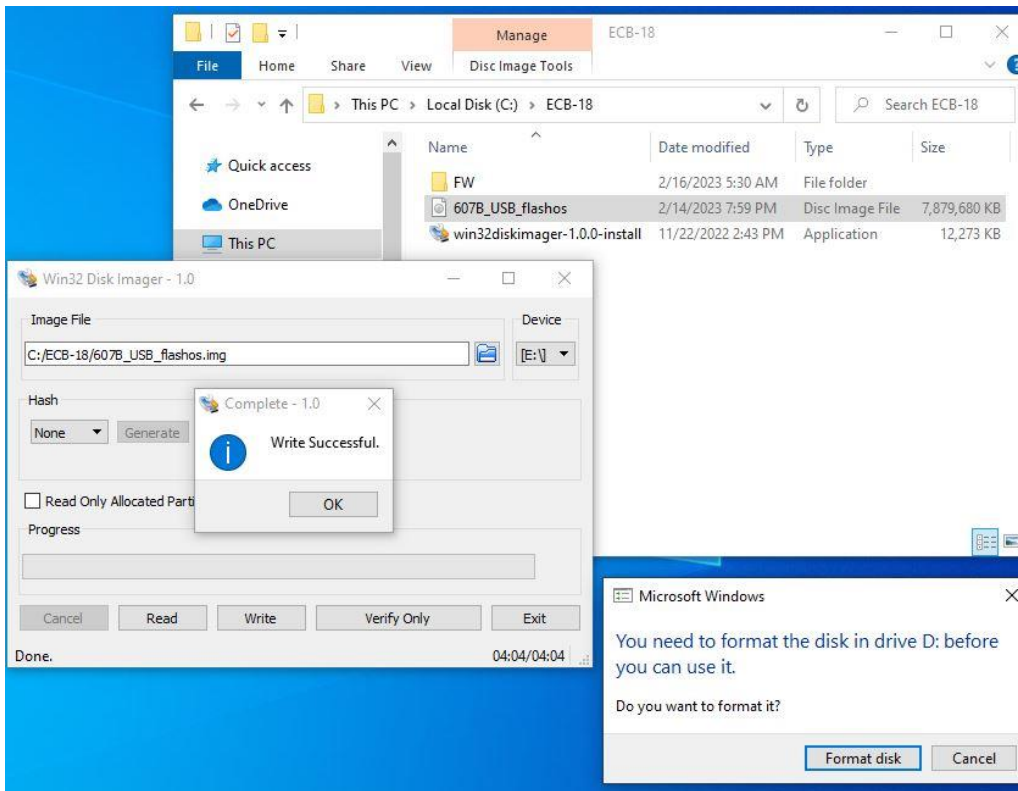


4) Select “Yes”

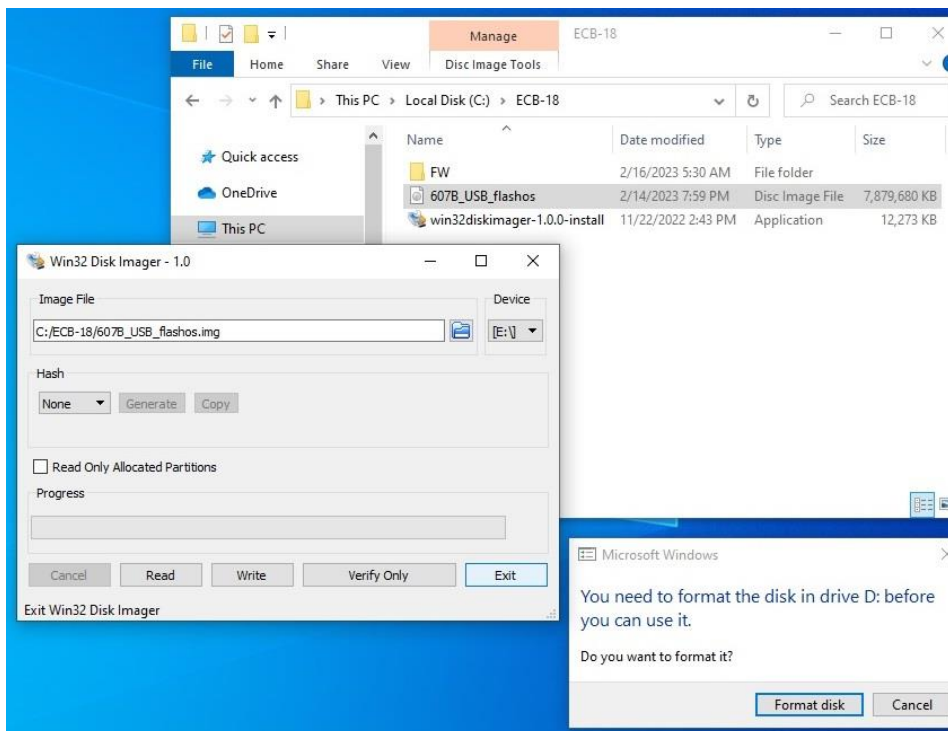




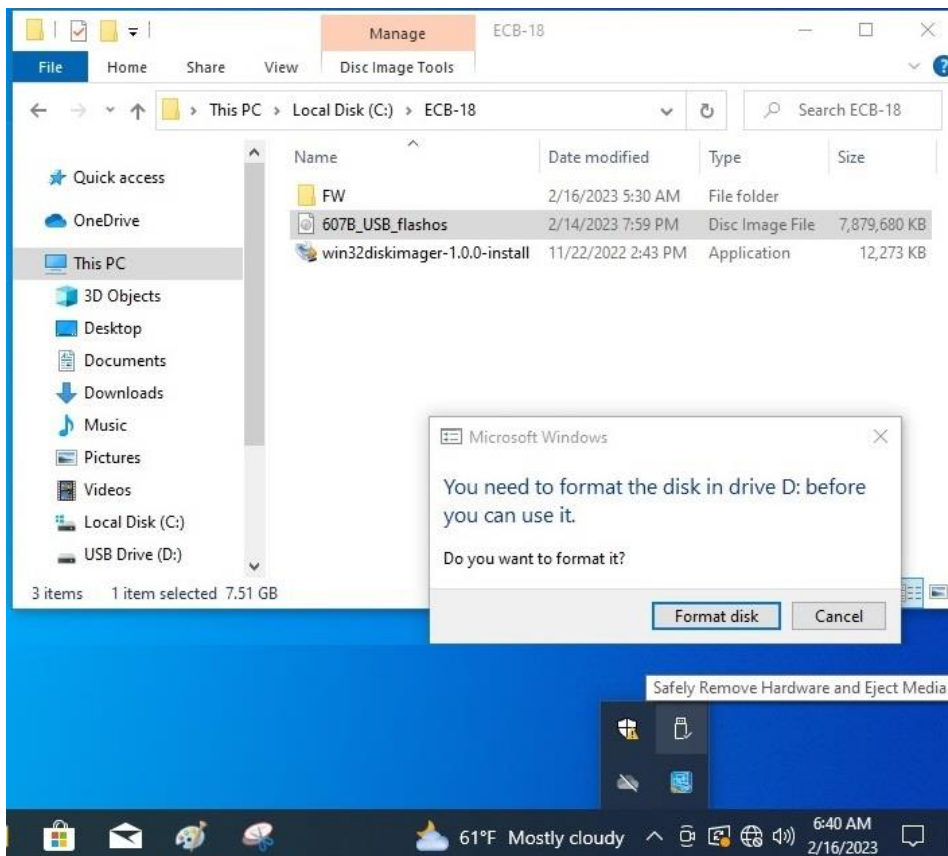
5) Select "OK"

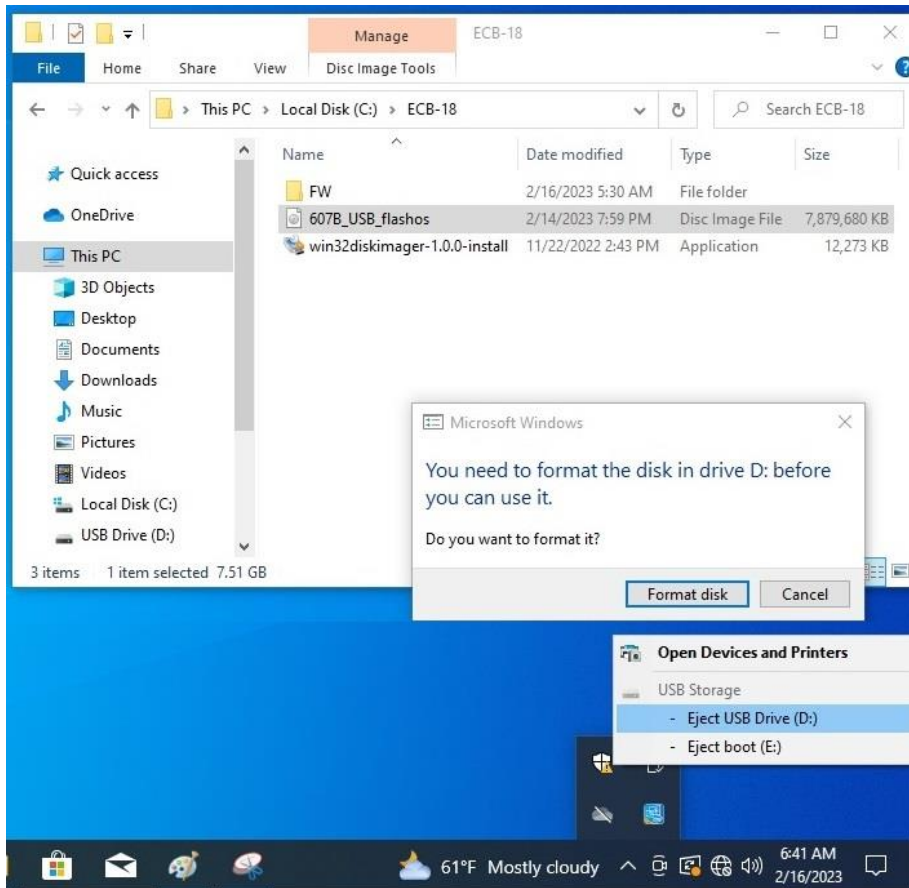


6) Select "Exit"



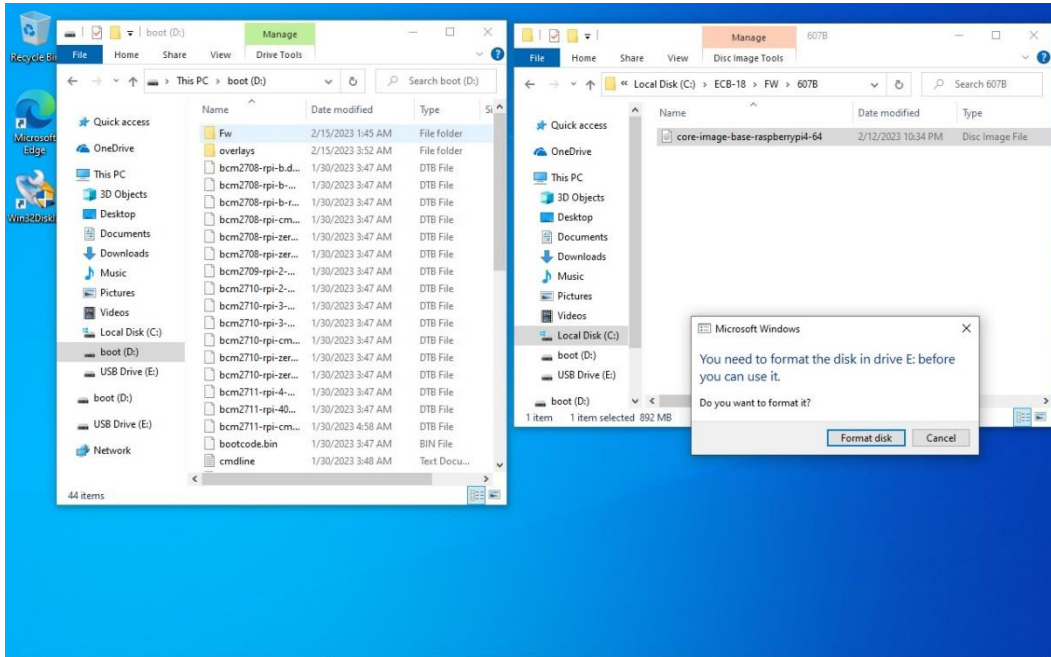
7) Safely Remove USB Disk



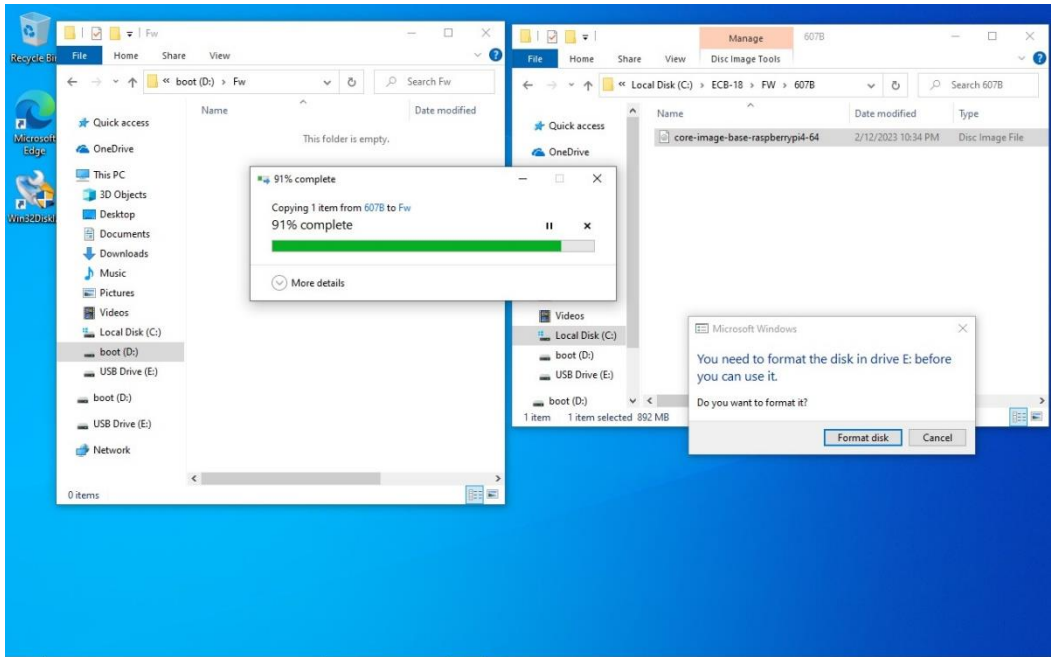


Step 3. → File3: core-image-base-raspberrypi4-64.img

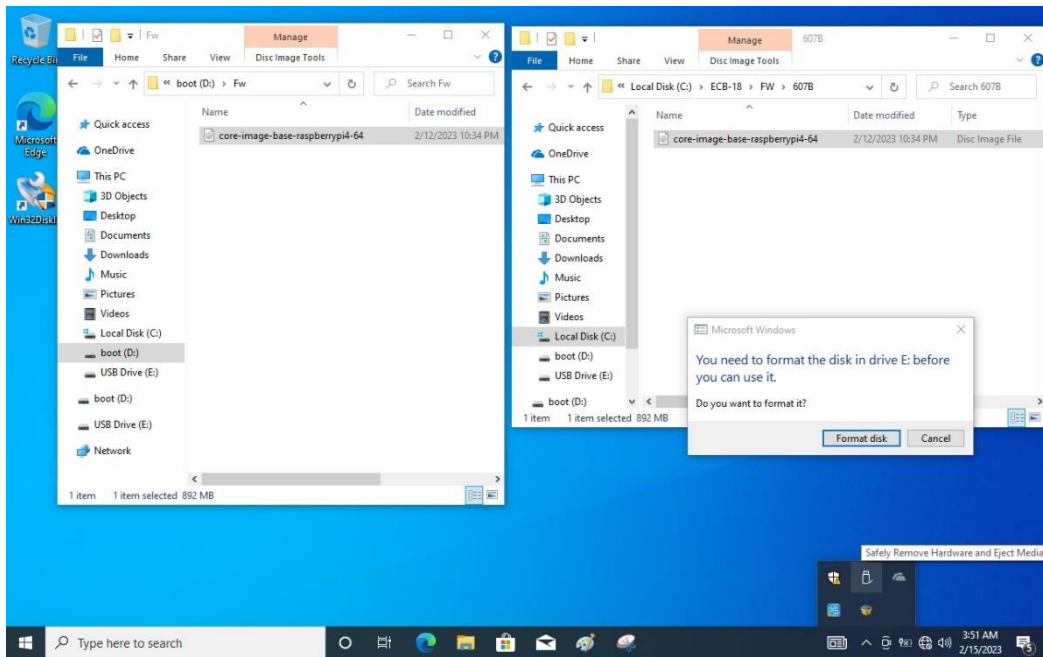
1) Plug-in USB boot disk to copy FW file.



2) Copy “core-image-base-raspberrypi4-64.img” file to USB boot disk “FW” folder.



3) Make USB boot image finished, then safely remove USB Disk.



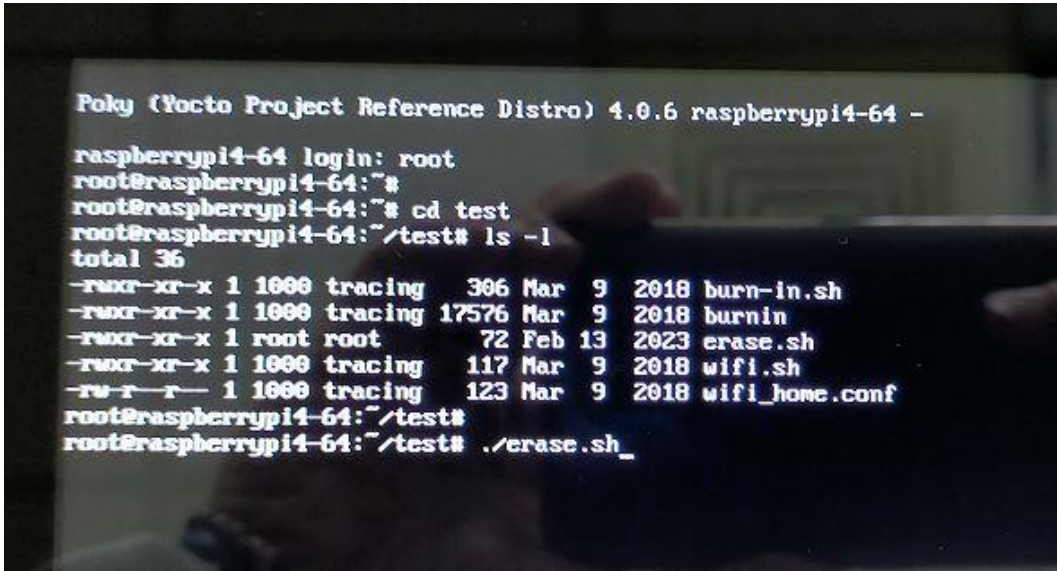
1. Key-in below command to erase the EMMC data.

login: **root**

cd test

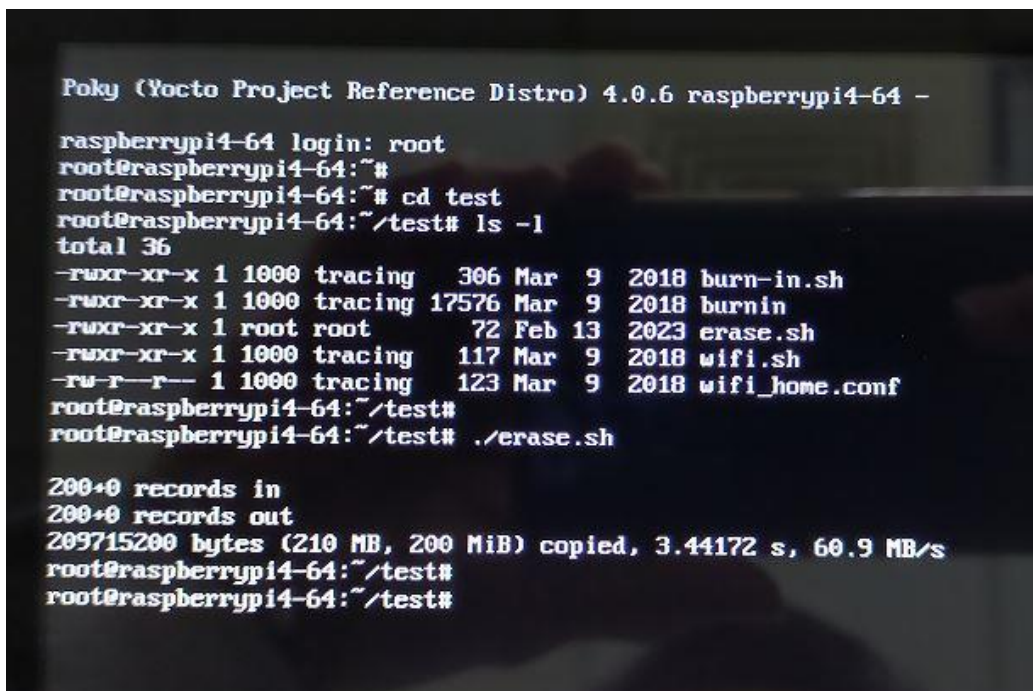
ls -l

./erase.sh



```
Poky (Yocto Project Reference Distro) 4.0.6 raspberrypi4-64 -
raspberrypi4-64 login: root
root@raspberrypi4-64:~#
root@raspberrypi4-64:~# cd test
root@raspberrypi4-64:~/test# ls -l
total 36
-rwxr-xr-x 1 1000 tracing 306 Mar 9 2018 burn-in.sh
-rwxr-xr-x 1 1000 tracing 17576 Mar 9 2018 burnin
-rwxr-xr-x 1 root root 72 Feb 13 2023 erase.sh
-rwxr-xr-x 1 1000 tracing 117 Mar 9 2018 wifi.sh
-rw-r--r-- 1 1000 tracing 123 Mar 9 2018 wifi_home.conf
root@raspberrypi4-64:~/test#
root@raspberrypi4-64:~/test# ./erase.sh_
```

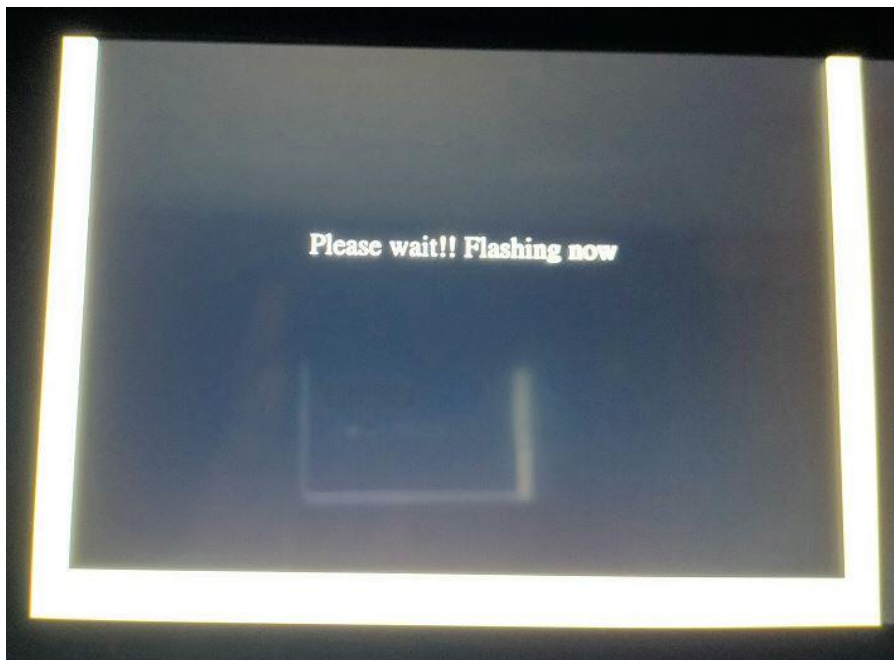
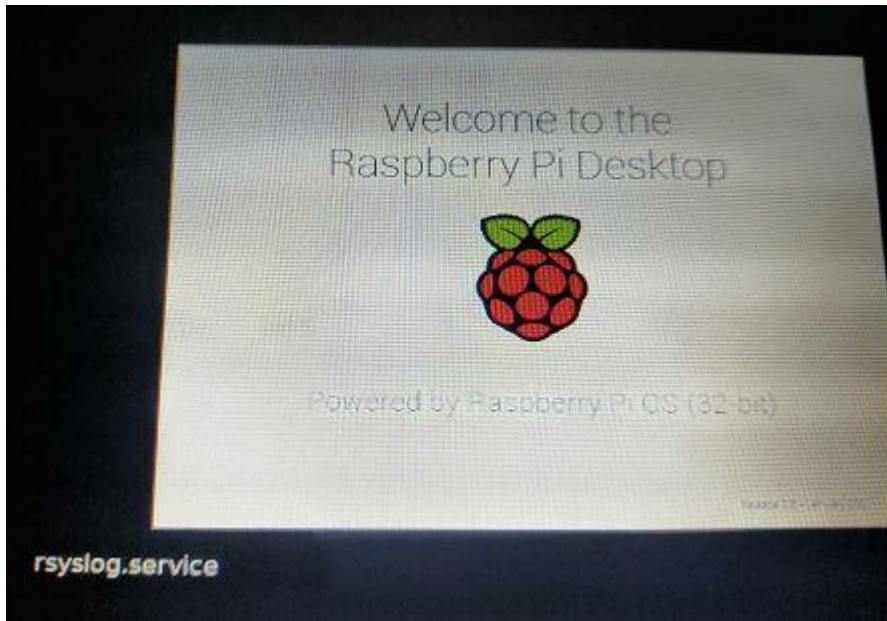
Erase successfully, Please Power Off.



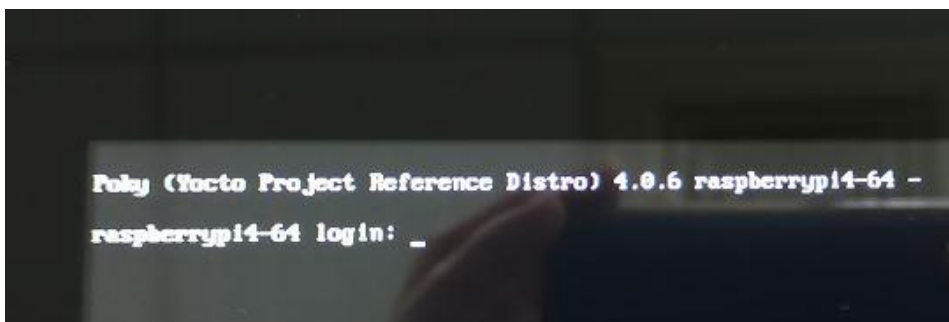
```
Poky (Yocto Project Reference Distro) 4.0.6 raspberrypi4-64 -
raspberrypi4-64 login: root
root@raspberrypi4-64:~#
root@raspberrypi4-64:~# cd test
root@raspberrypi4-64:~/test# ls -l
total 36
-rwxr-xr-x 1 1000 tracing 306 Mar 9 2018 burn-in.sh
-rwxr-xr-x 1 1000 tracing 17576 Mar 9 2018 burnin
-rwxr-xr-x 1 root root 72 Feb 13 2023 erase.sh
-rwxr-xr-x 1 1000 tracing 117 Mar 9 2018 wifi.sh
-rw-r--r-- 1 1000 tracing 123 Mar 9 2018 wifi_home.conf
root@raspberrypi4-64:~/test#
root@raspberrypi4-64:~/test# ./erase.sh

200+0 records in
200+0 records out
209715200 bytes (210 MB, 200 MiB) copied, 3.44172 s, 60.9 MB/s
root@raspberrypi4-64:~/test#
root@raspberrypi4-64:~/test#
```

2. Plug-in USB boot disk to ARMPAC-607BP/610BP, then power on.

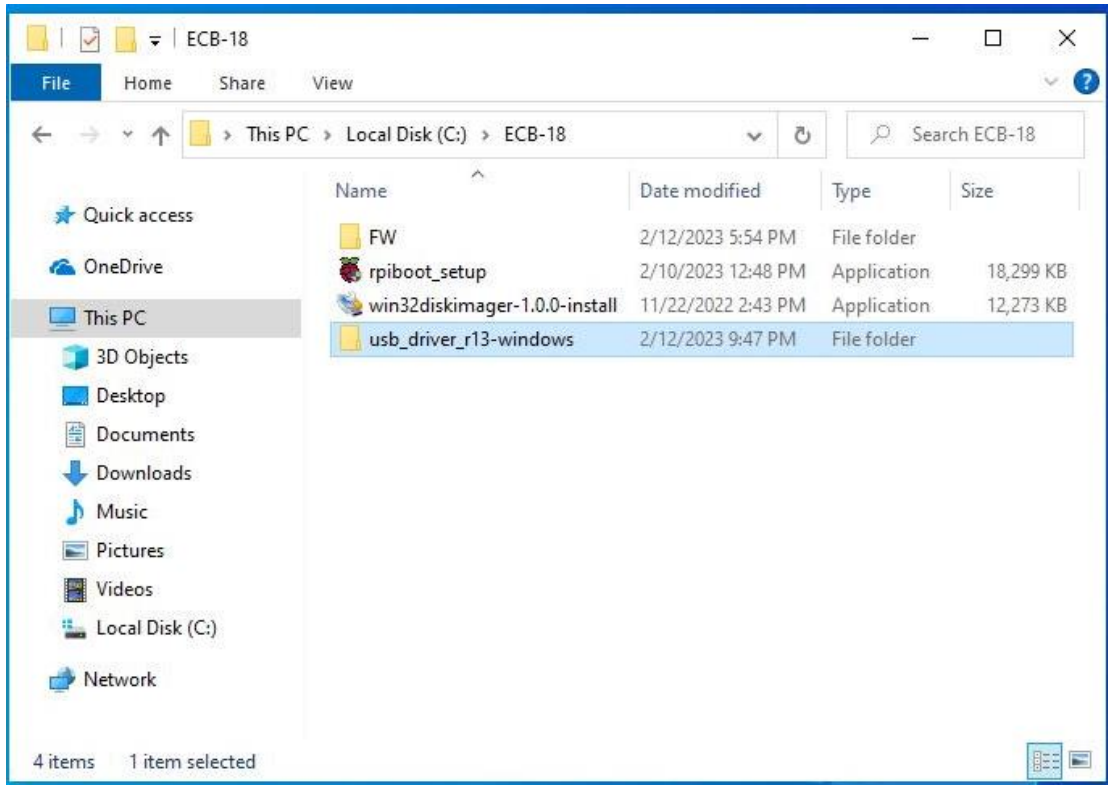


3. Yocto Linux have been updated successfully!!



3.2 Update Android Firmware

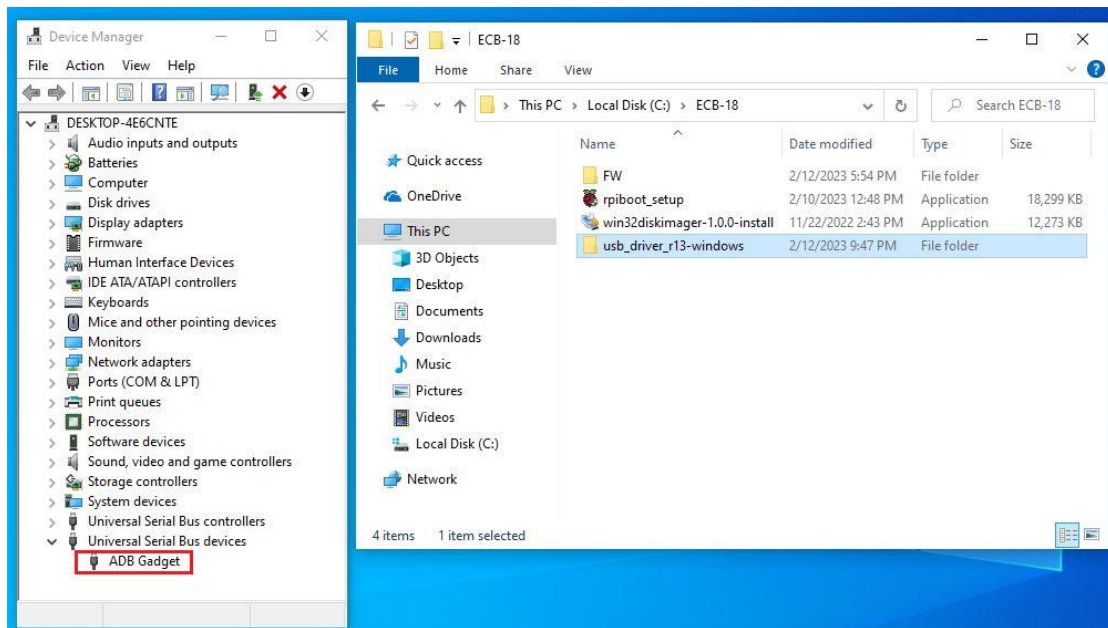
To update Android firmware, there must be four files as shown below.



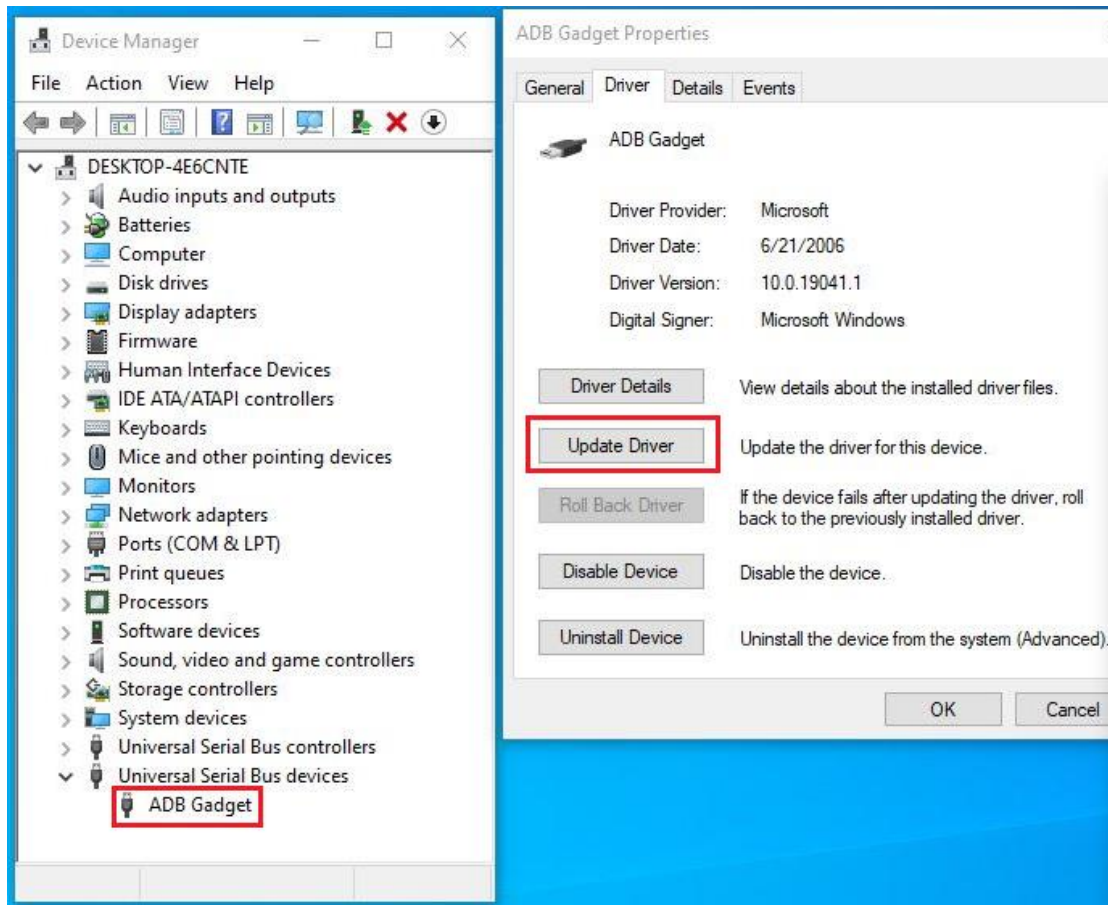
1. **File1: [usb_driver_r13-windows.zip](#)**
Google USB Driver (ADB Interface Driver).
2. **File2: [win32diskimager-1.0.0-install.exe](#)**
Make FW boot partition image tool.
3. **File3: [rpiboot_setup.exe](#)**
Connection eMMC tool.
4. **File4: [FW image files](#)**
Erase eMMC File & update utility & Android Firmware Files

Step 1. → File1: [usb_driver_r13-windows.zip](#)

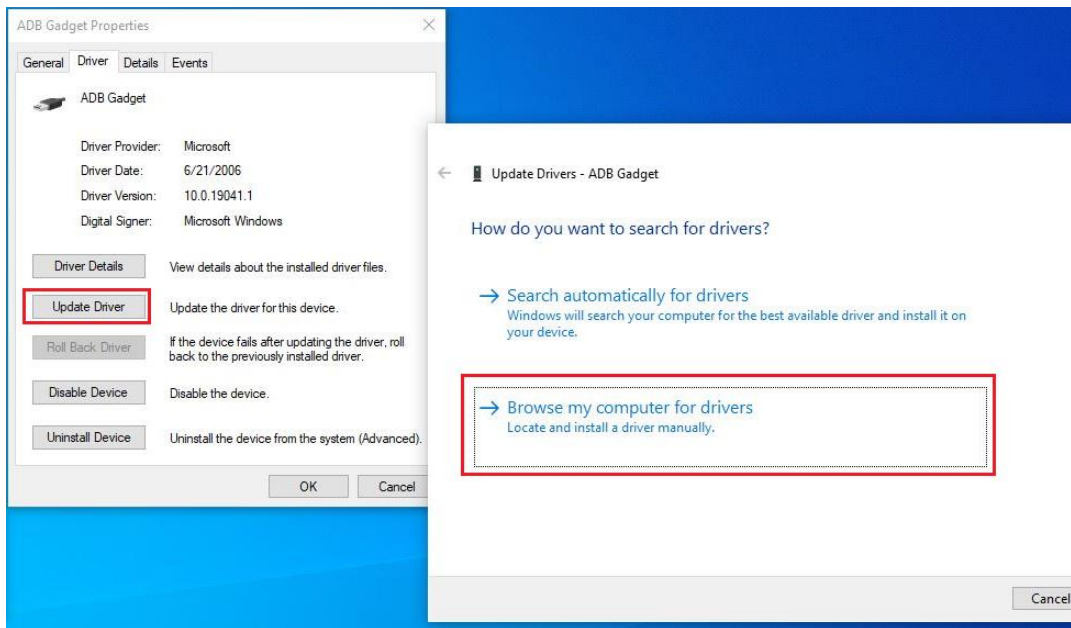
- 1) Connect Micro USB Cable from ARMPAC-607BP/610BP to your desktop/laptop and Install ADB Interface Driver.



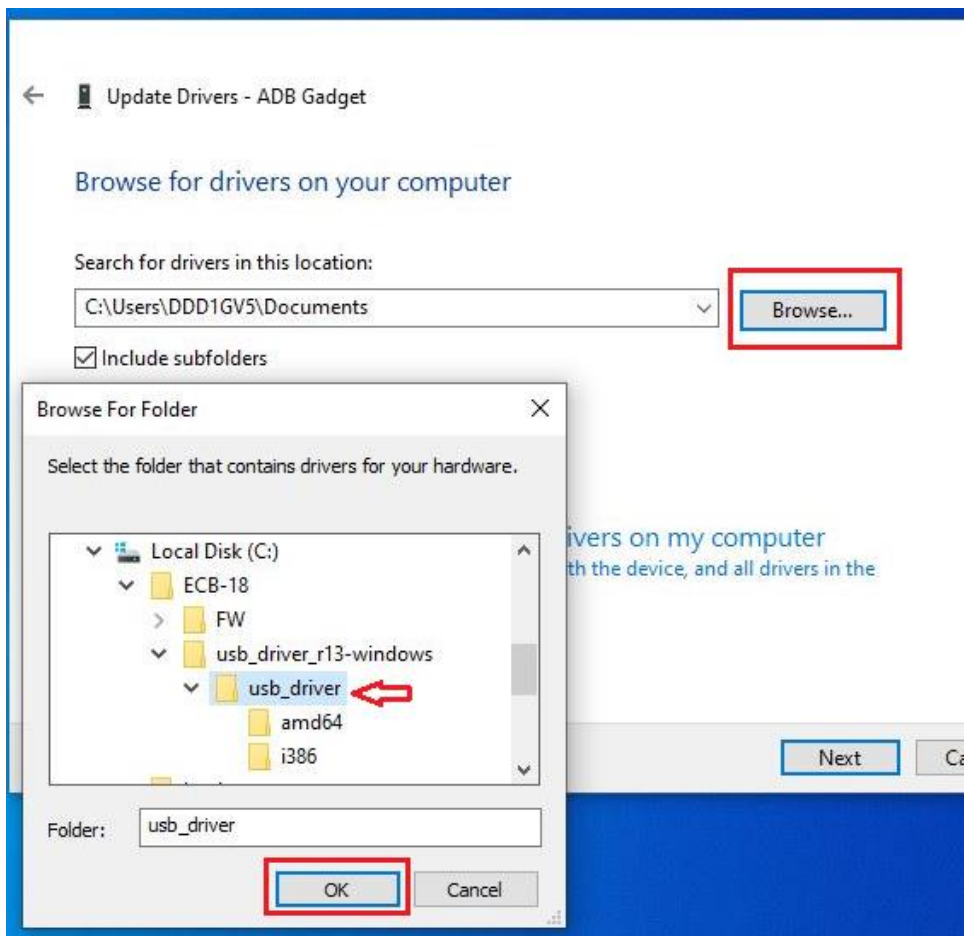
- 2) Double click “ADB Gadget” to “Update Driver”.



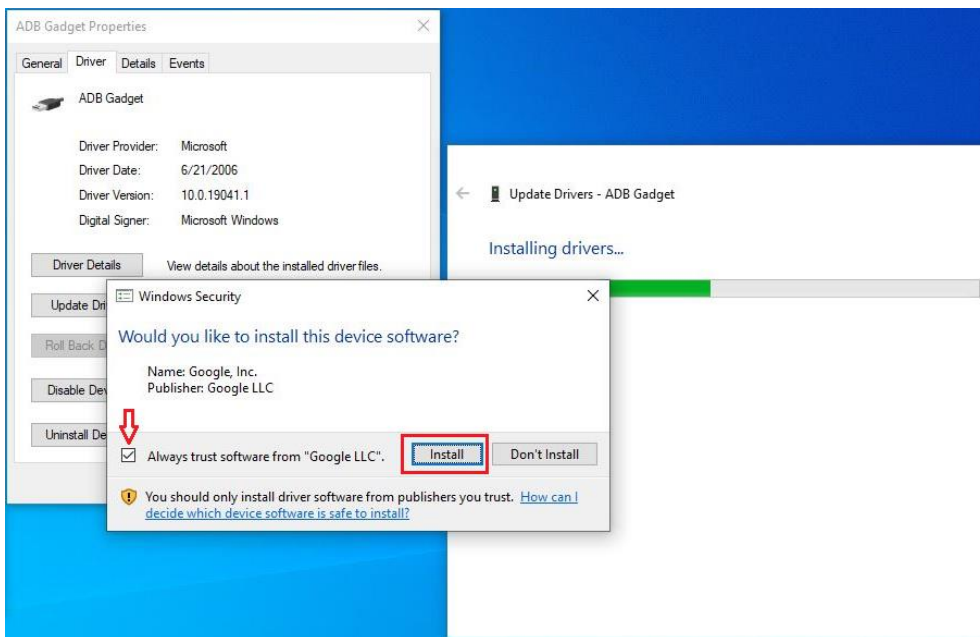
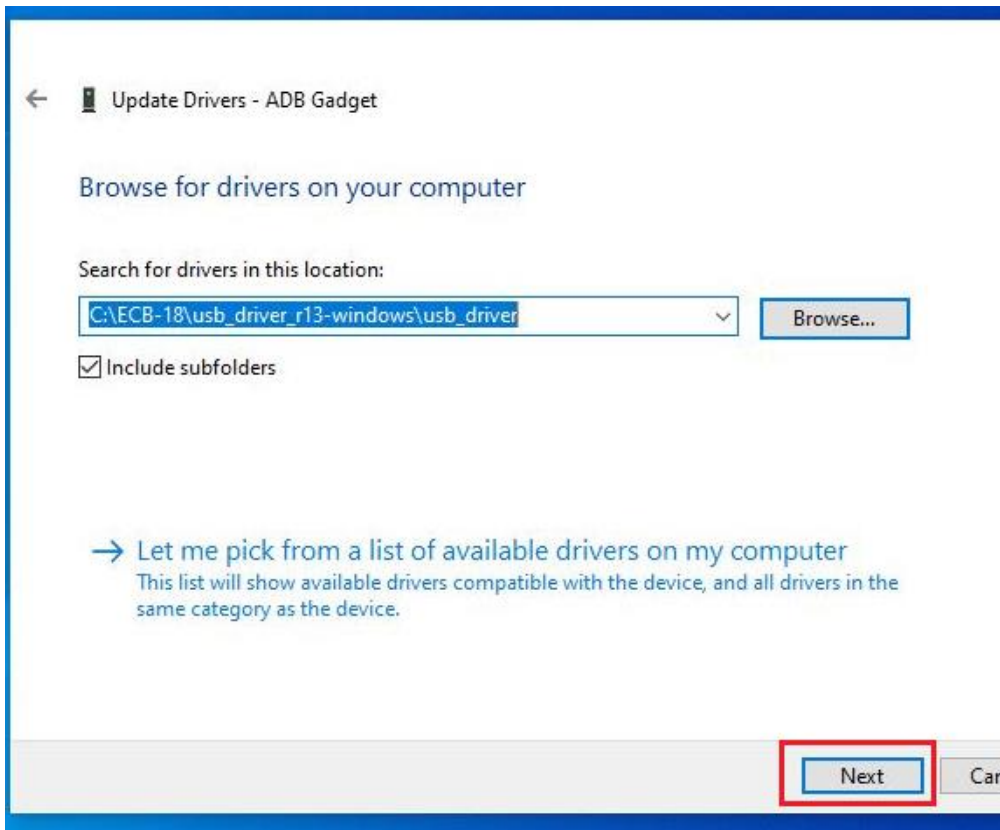
3) Select “Browse my computer for driver software” to locate and install driver software.



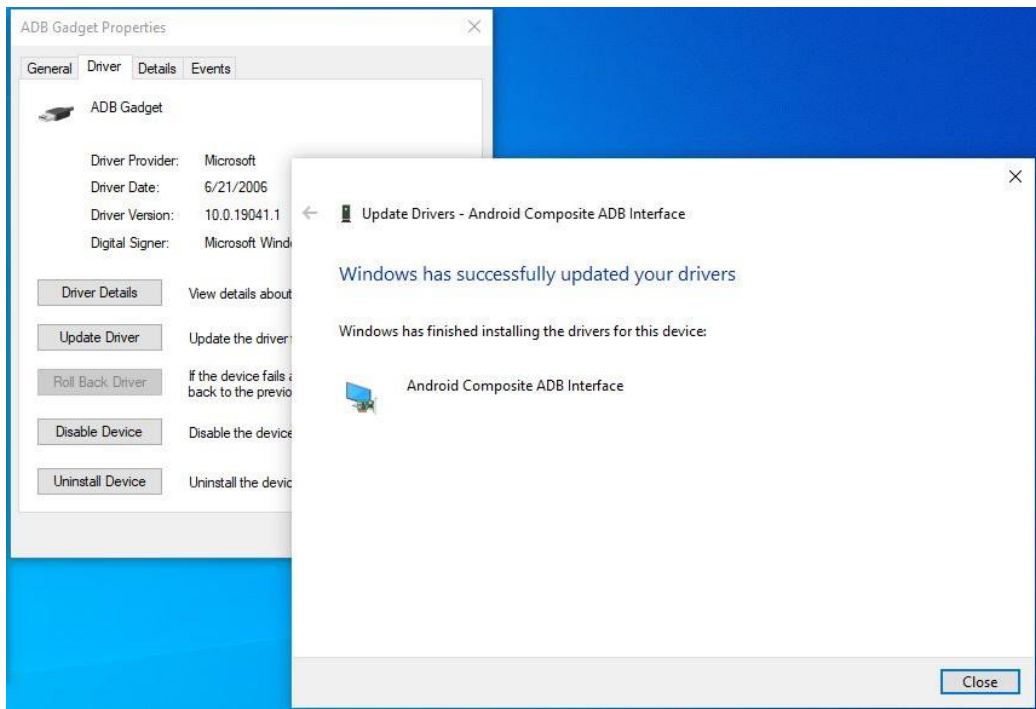
4) Click “Browse” to \usb_driver_r13-windows\usb_driver\



5) Click "Browse" to \usb_driver_r13-windows\usb_driver\

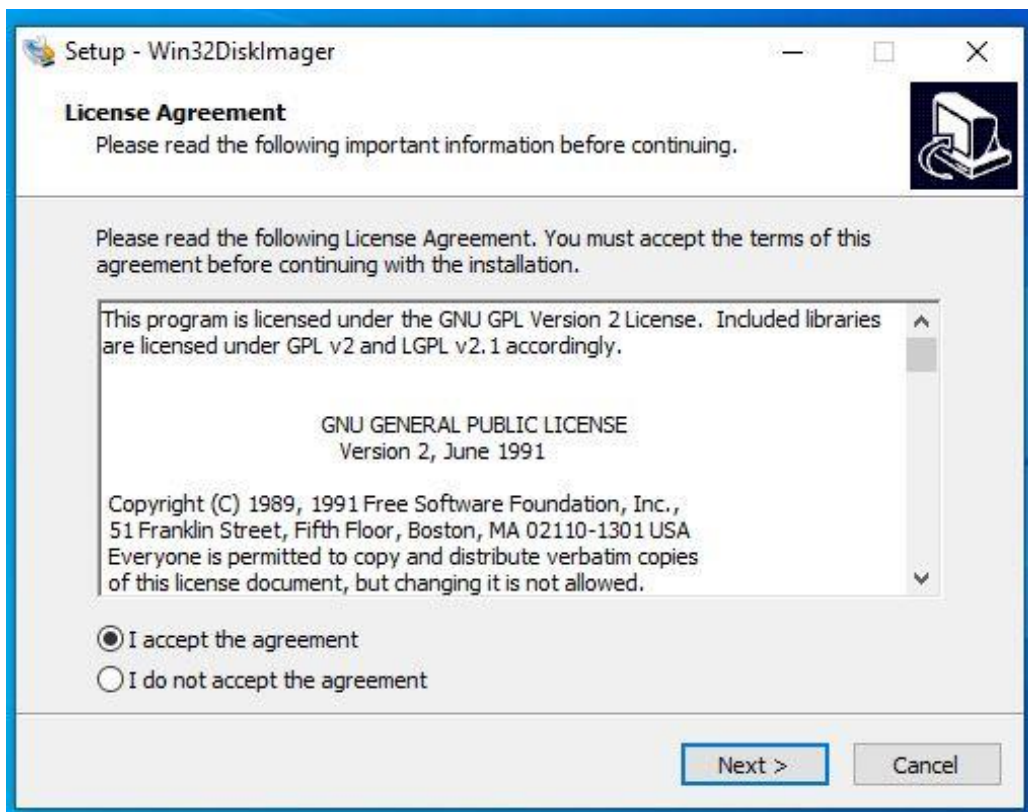
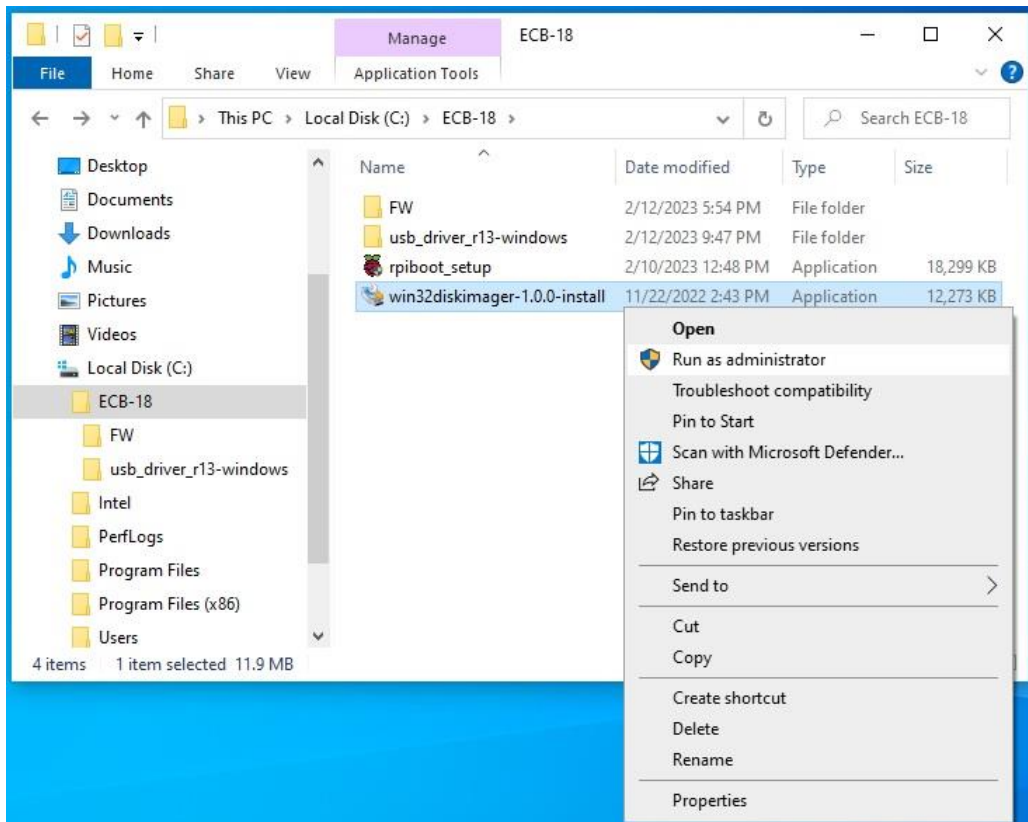


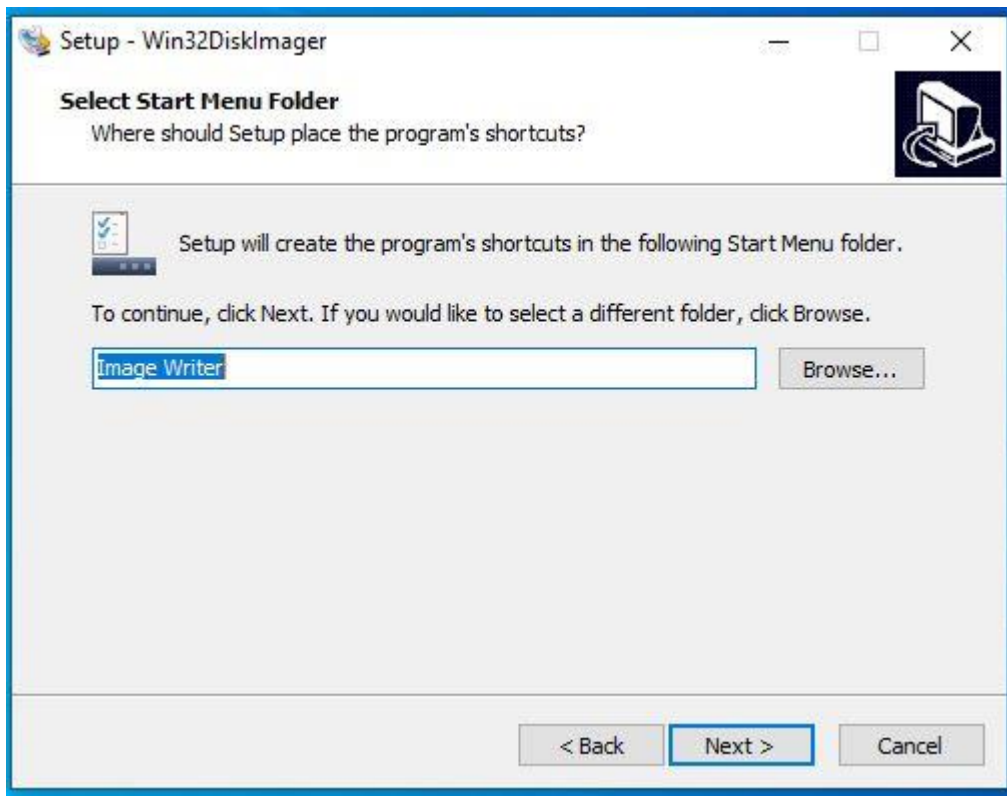
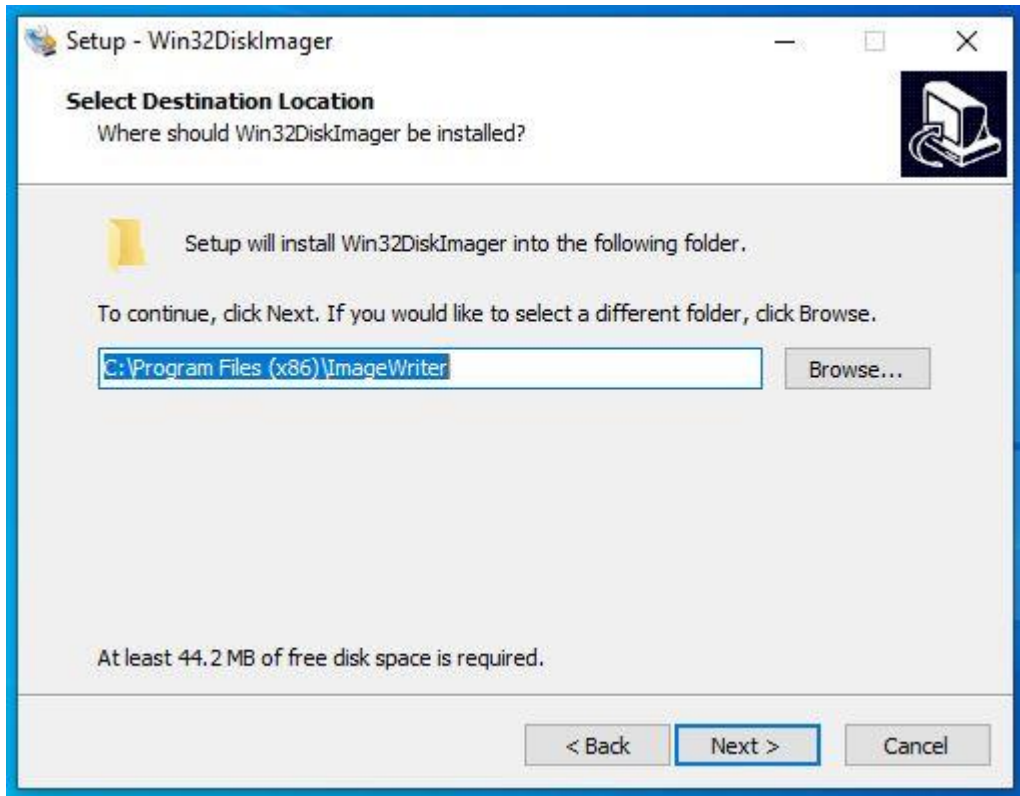
6) Click “Close” to complete the driver installation.

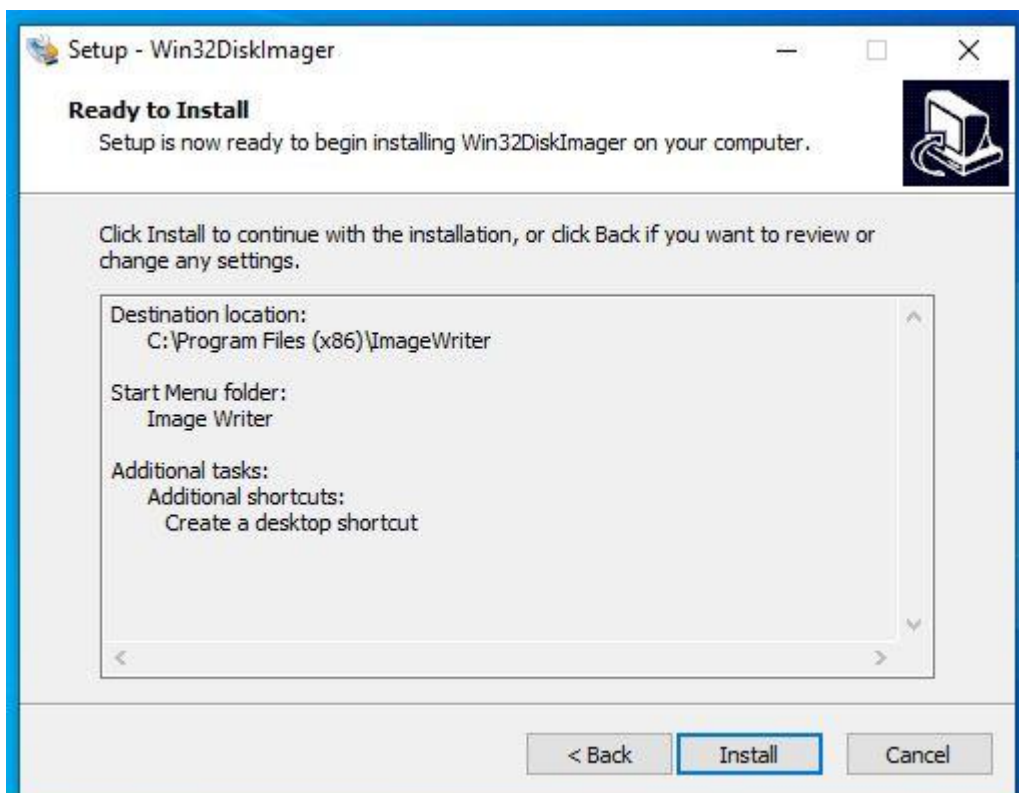
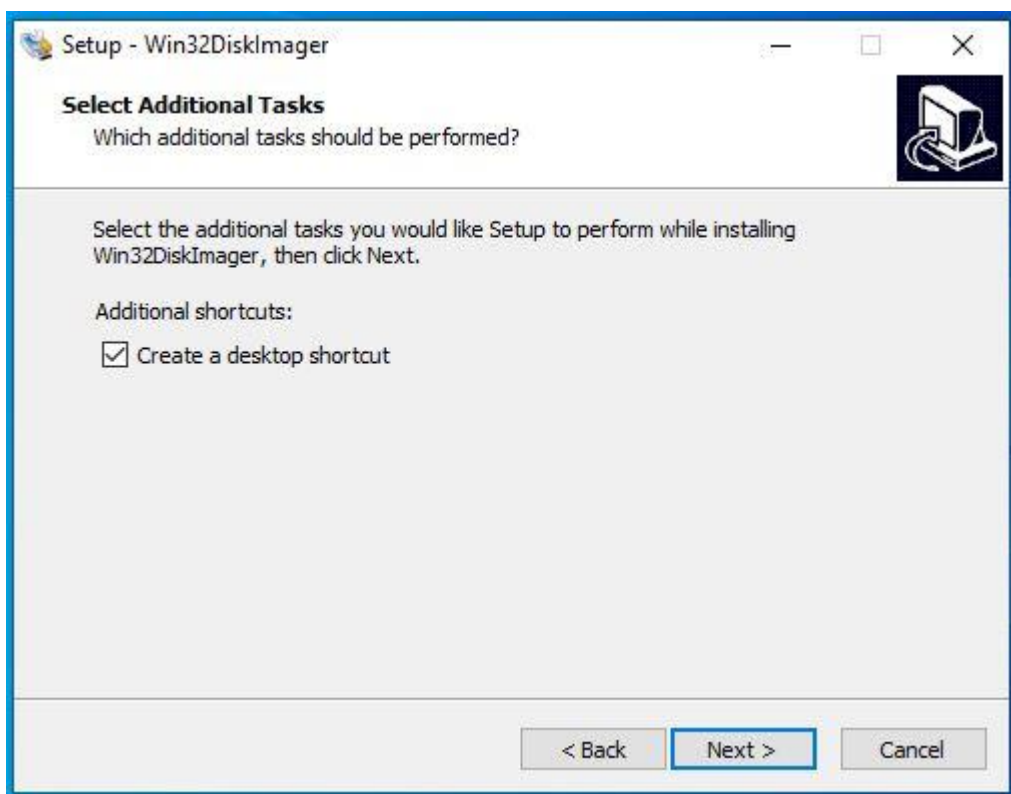


Step 2. → File2: win32diskimager-1.0.0-install.exe

1) Install “win32diskimager-1.0.0-install.exe”.



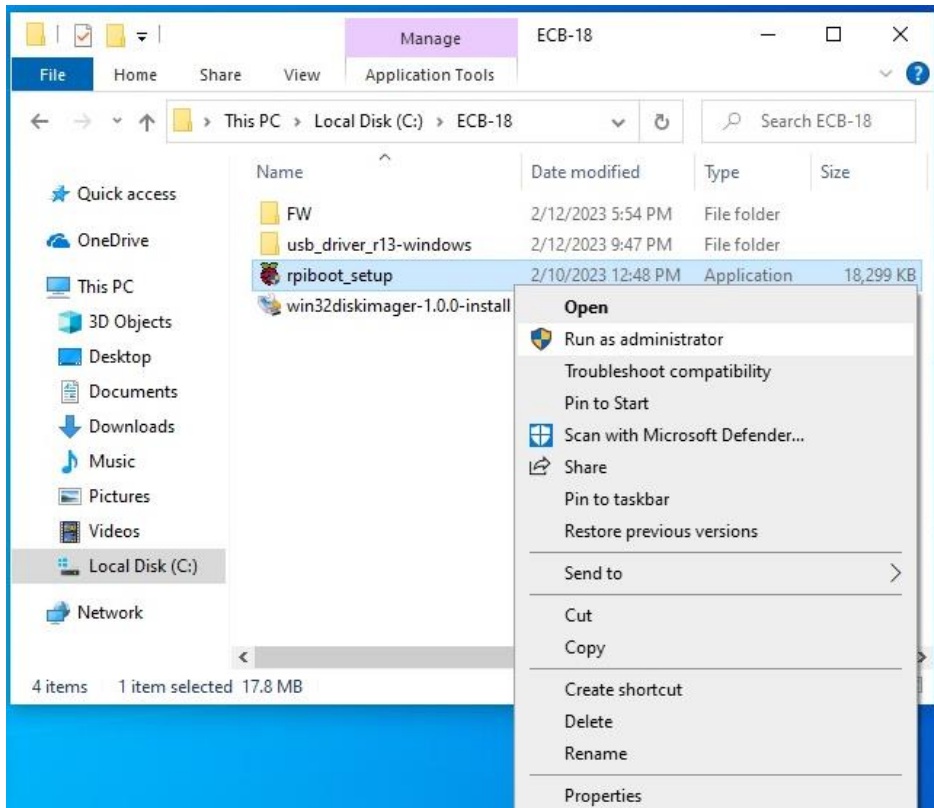


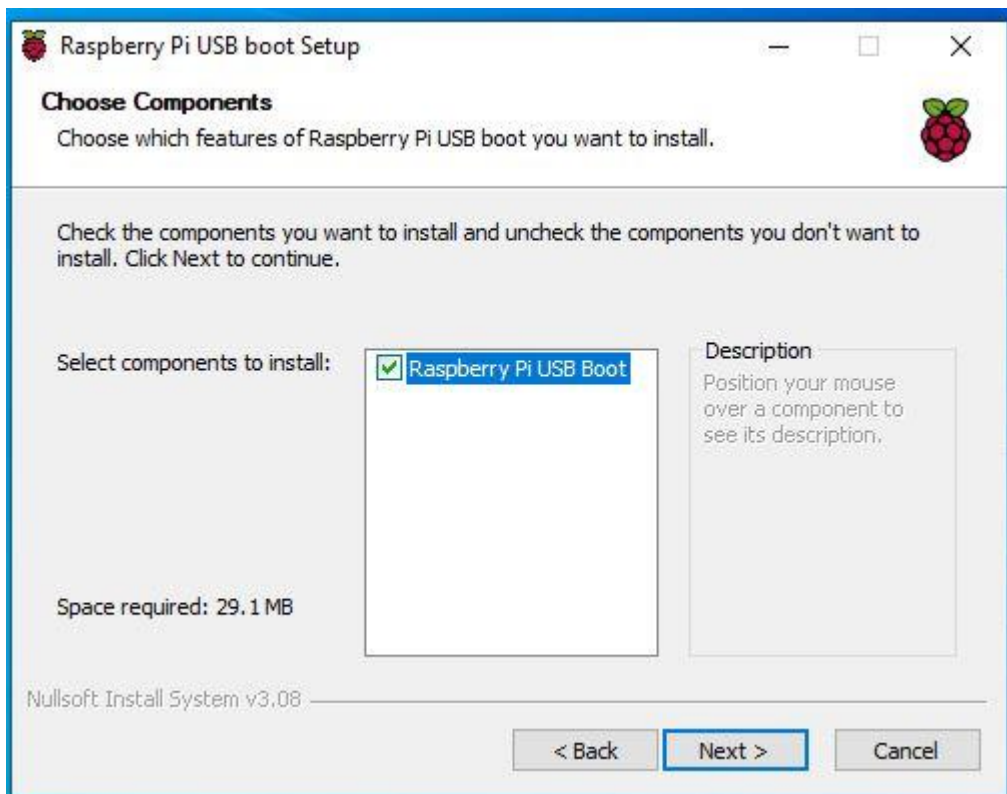
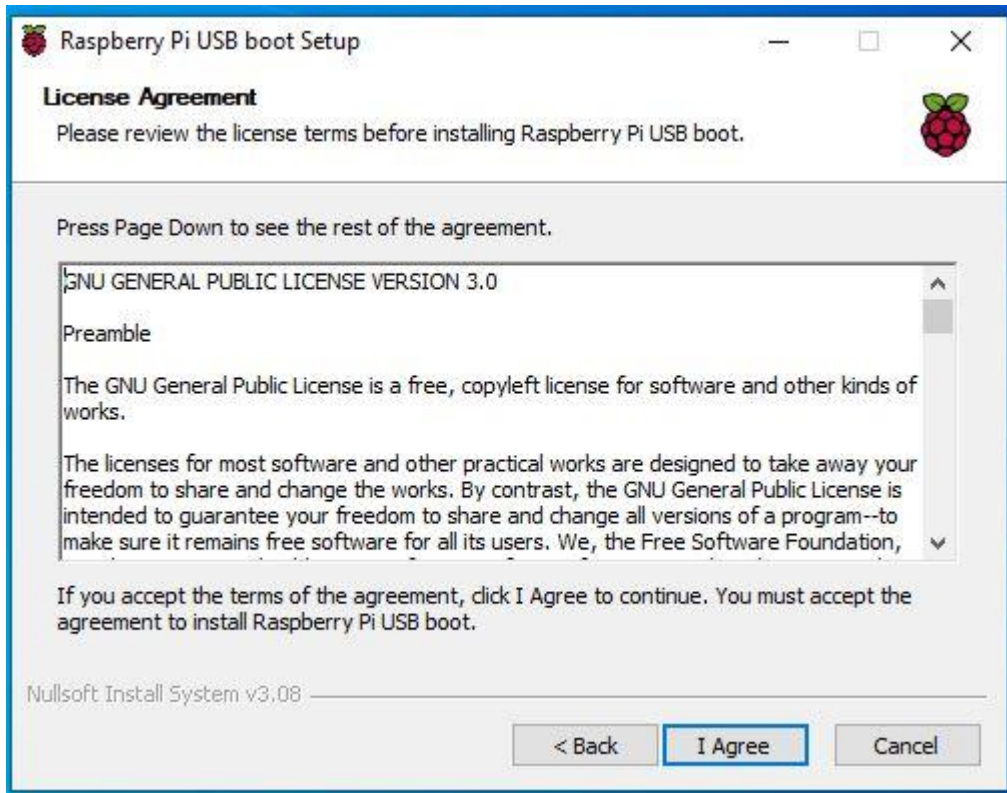


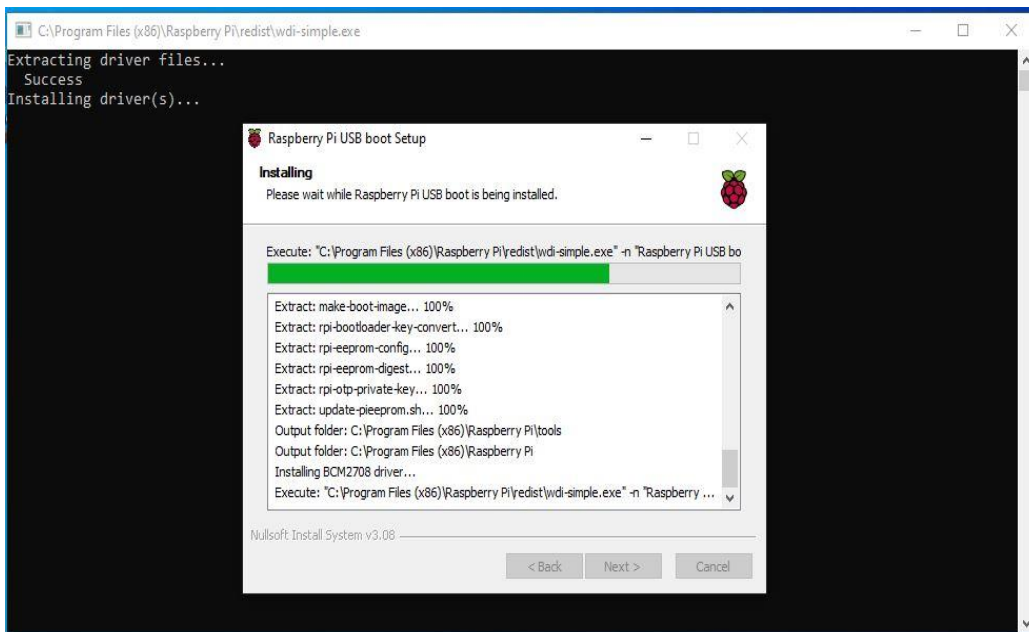
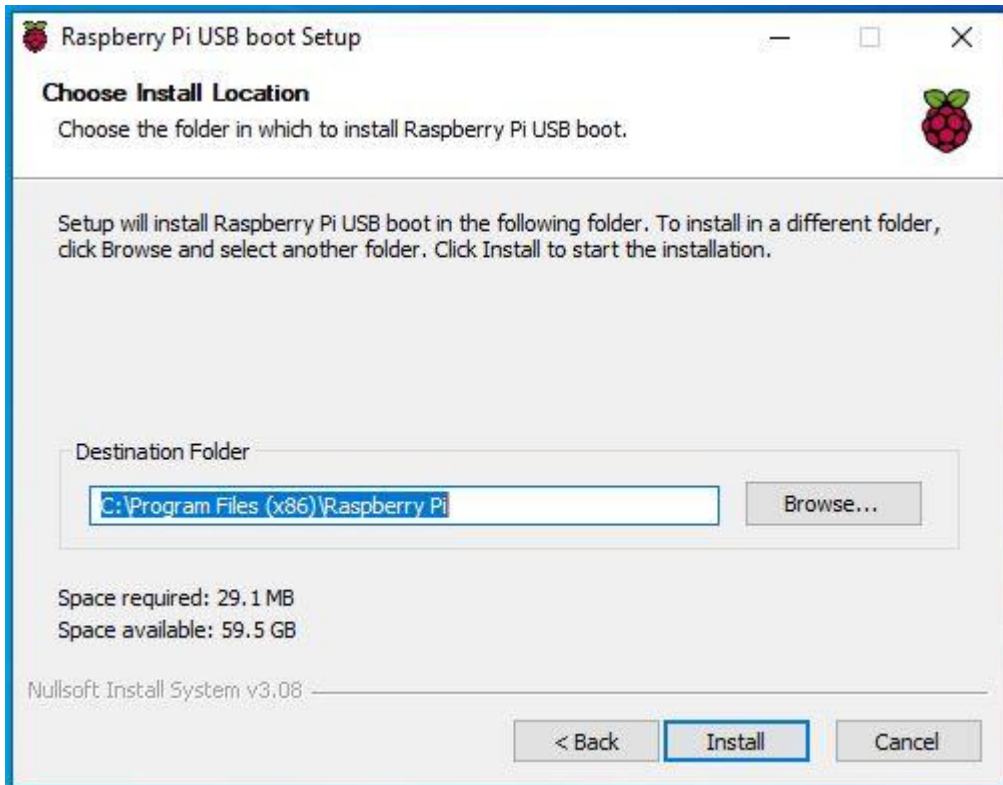


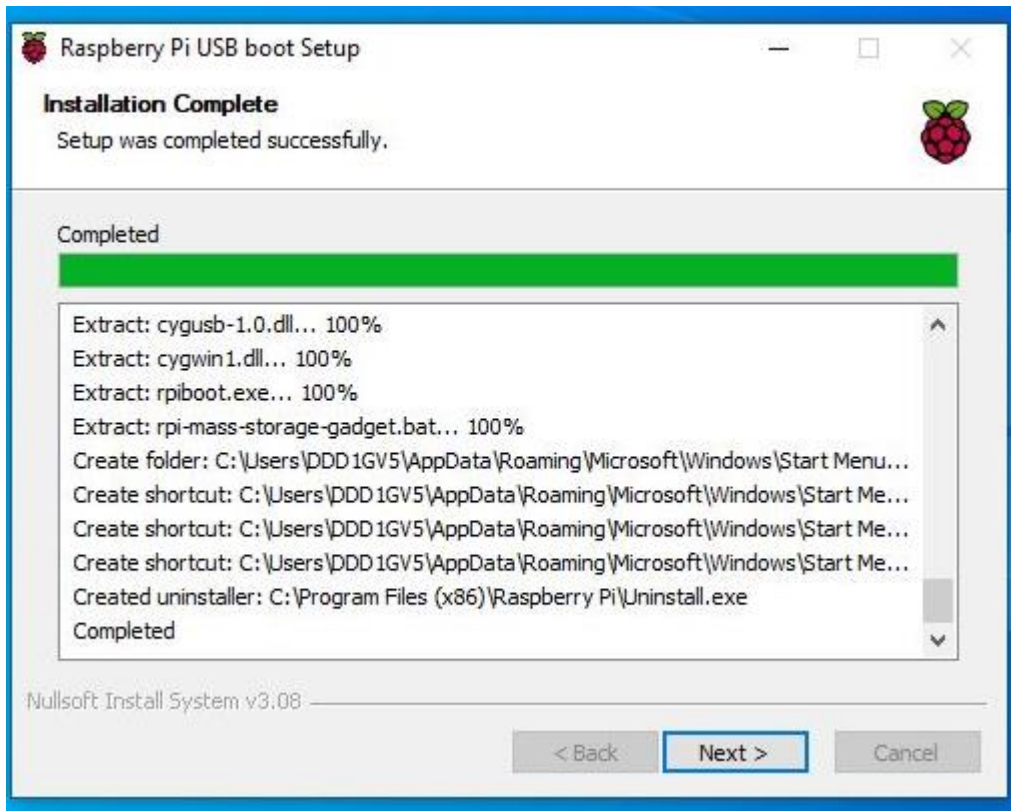
Step 3. → File3: rpiboot_setup.exe

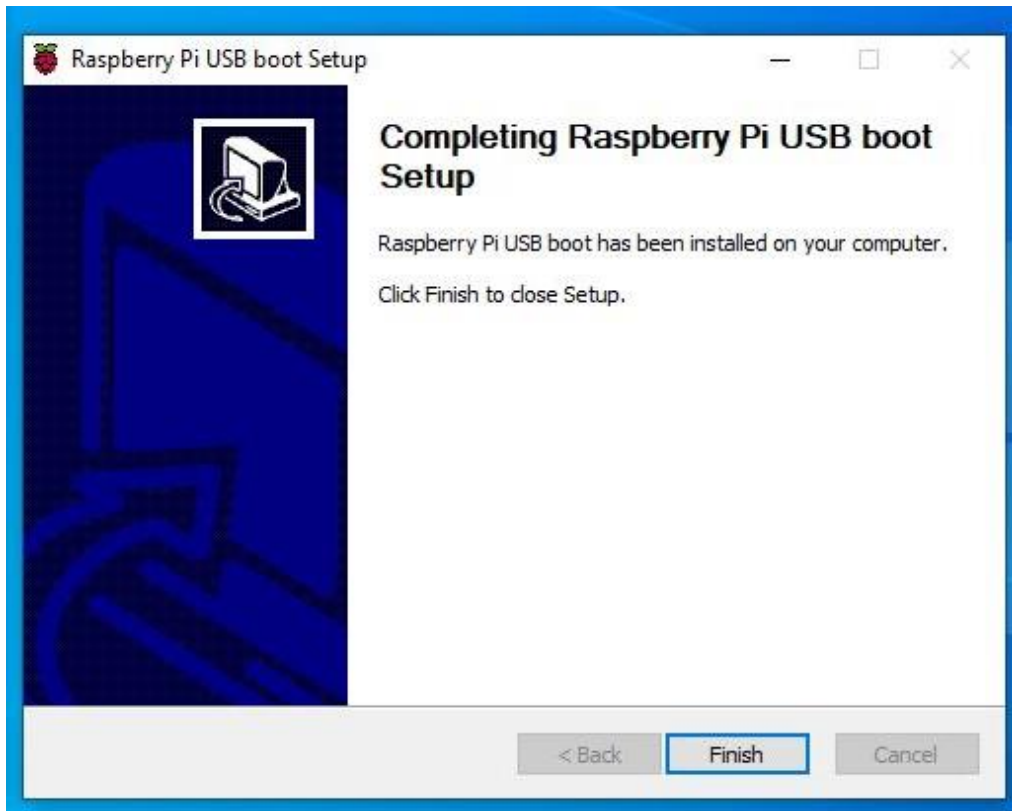
1) Install “rpiboot_setup.exe”.





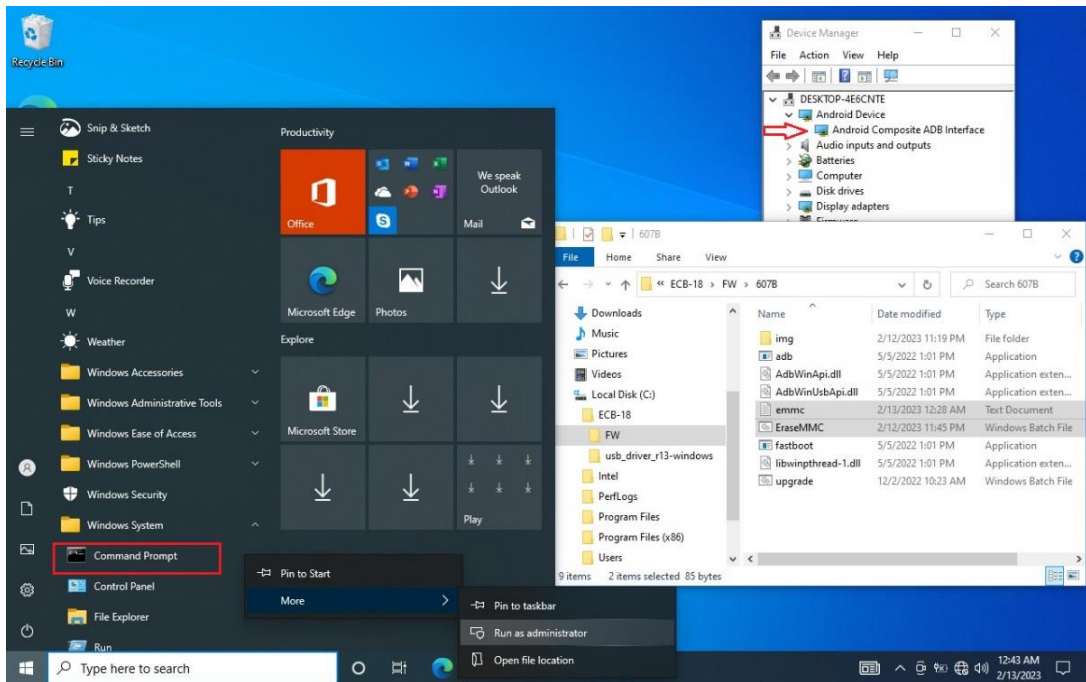




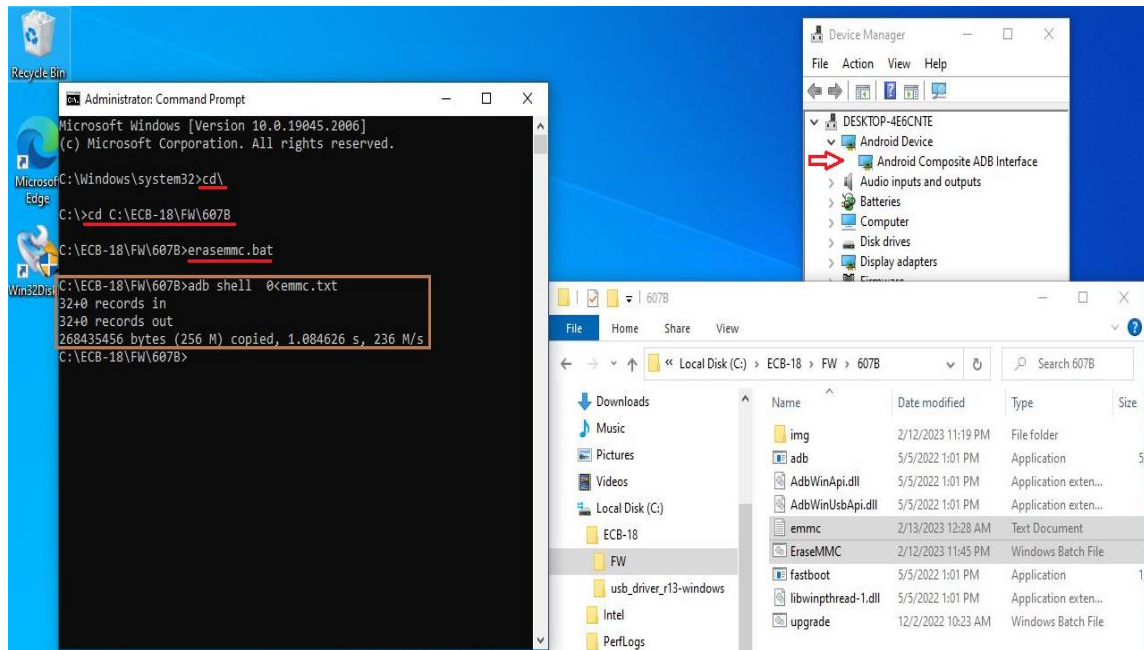


Step 4. → File4: FW image files (Erase eMMC)

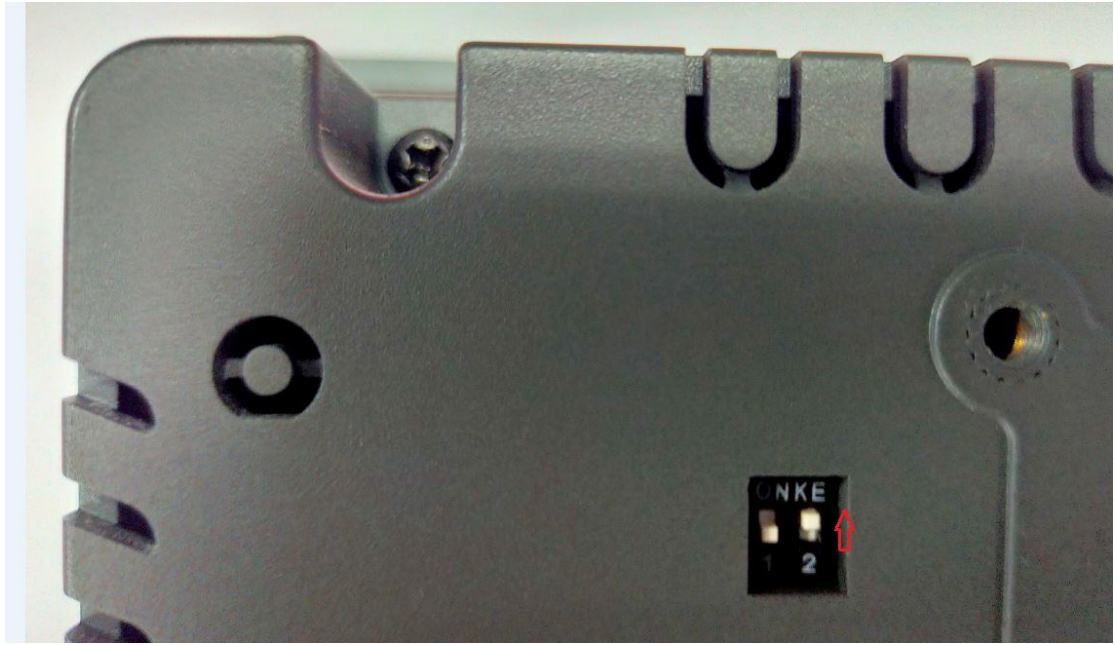
- 1) Connect Micro USB Cable from ARMPAC-607BP/610BP to your desktop/laptop.
- 2) Run “Command Prompt”



- 3) Change the path to the FW placement directory
- 4) Key-in “EraseMMC.bat”

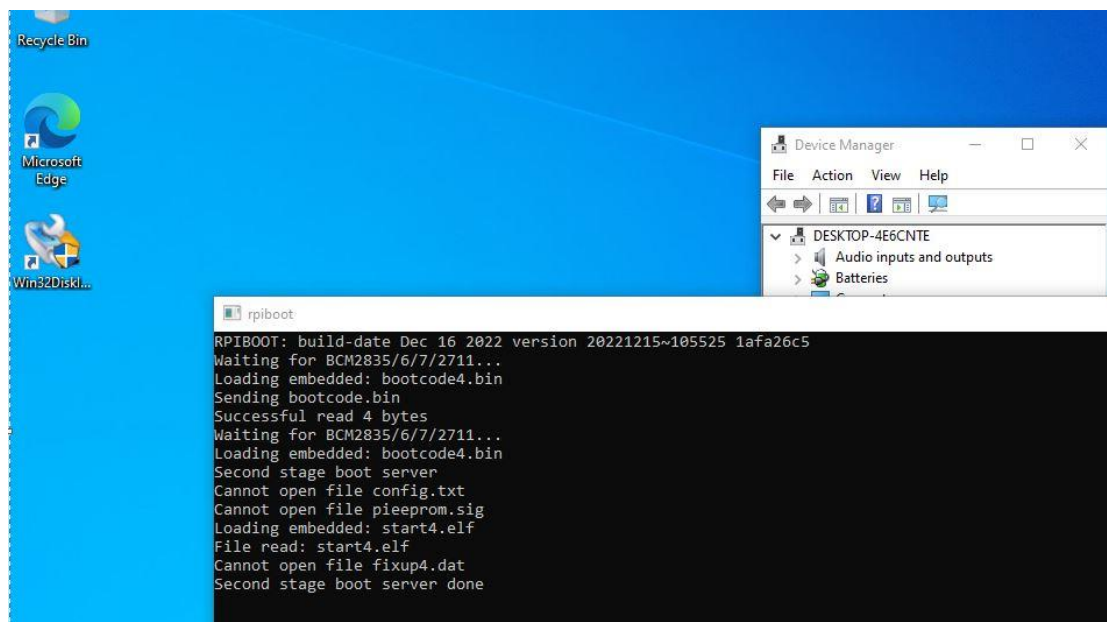
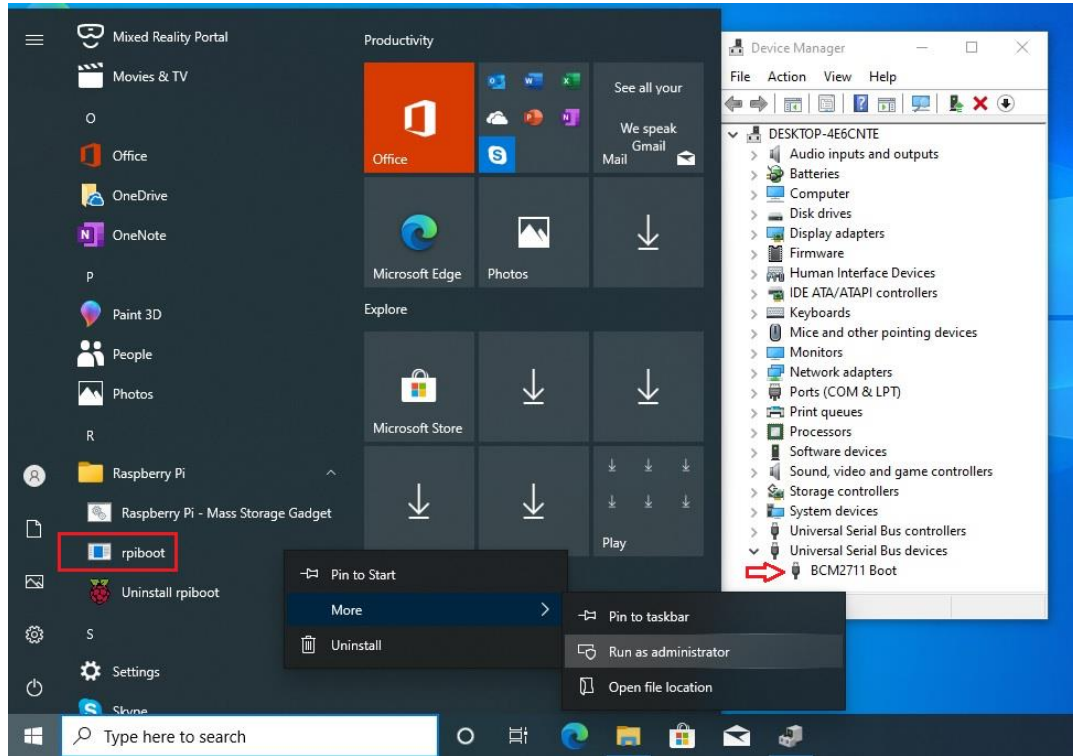


- 5) Power off, then change Dip-Switch 2 to **ON** (Download Mode).

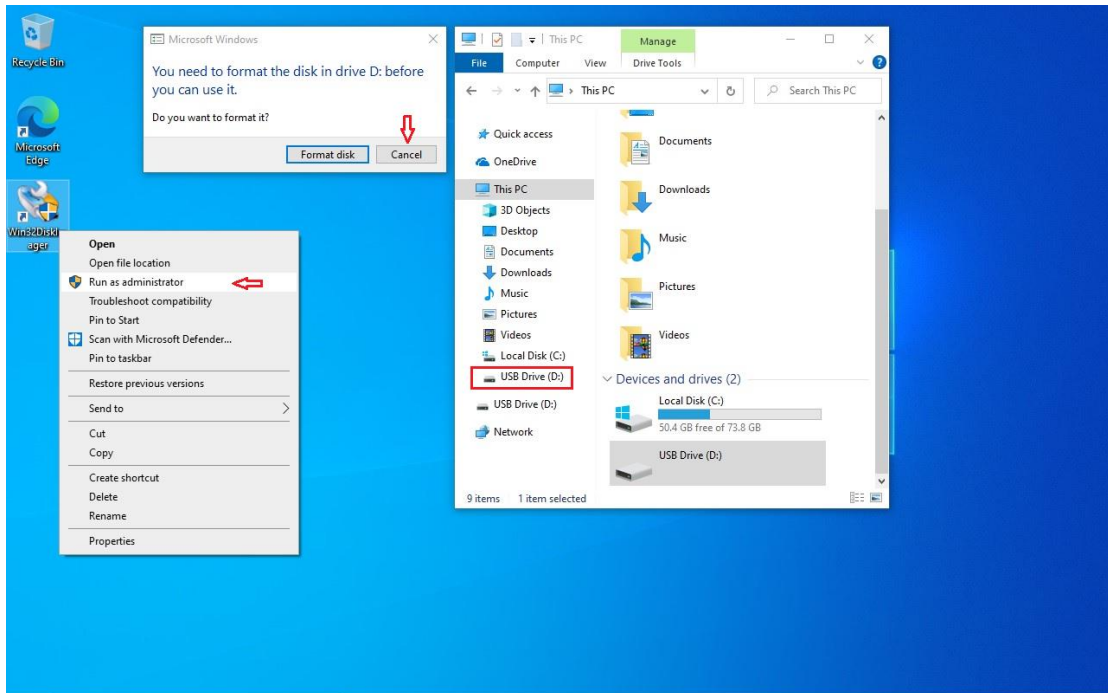


Step 5. → Run “rpiboot” utility to connect eMMC.

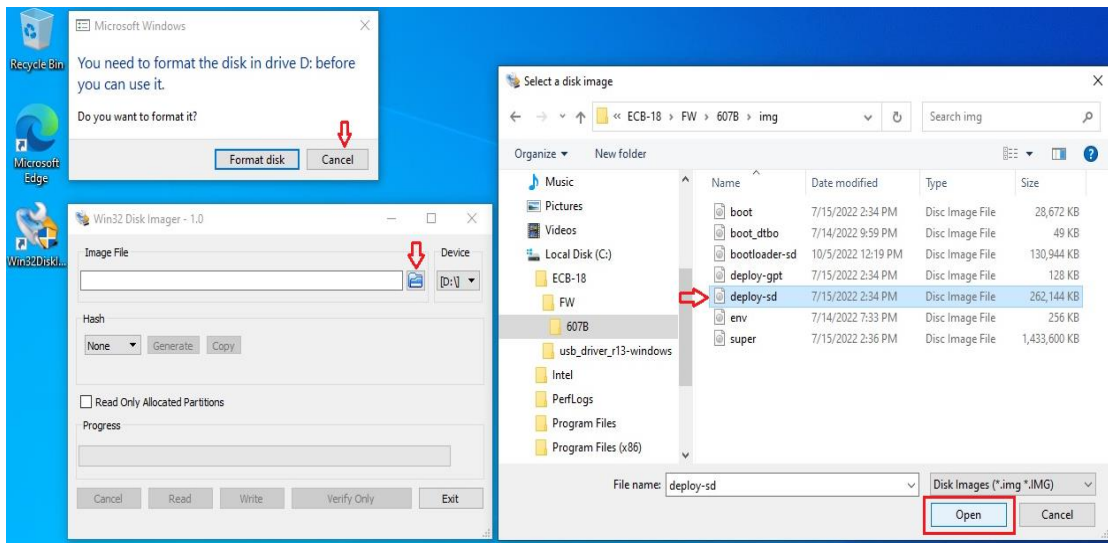
- 1) Connect Micro USB Cable from ARMPAC-607BP/610BP to your desktop/laptop.
- 2) Power on ARMPAC-607BP/610BP.
- 3) Run “rpiboot” utility

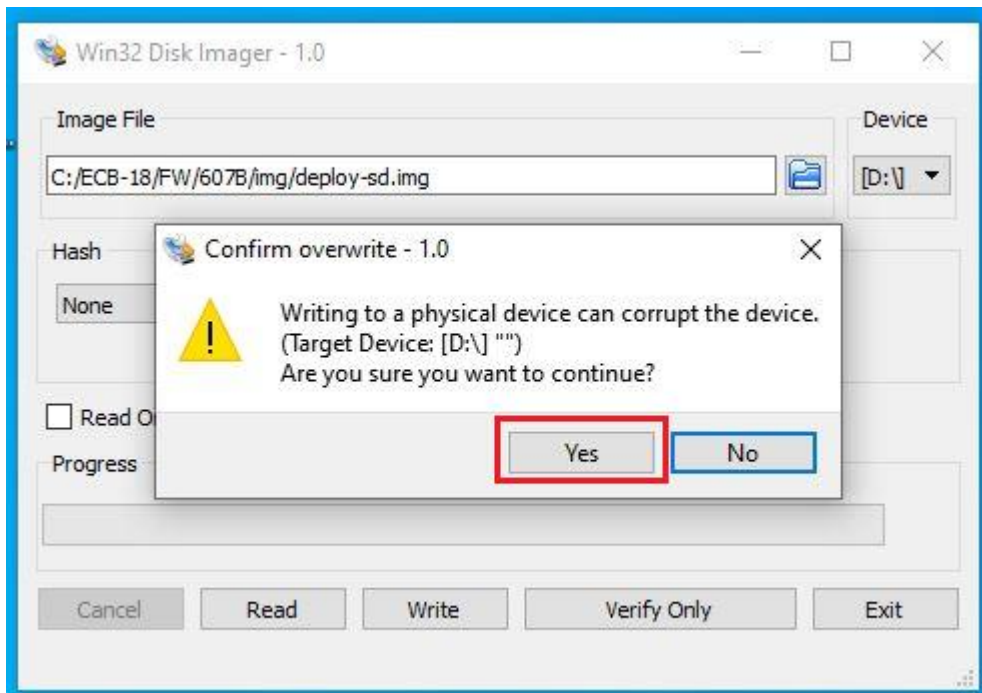
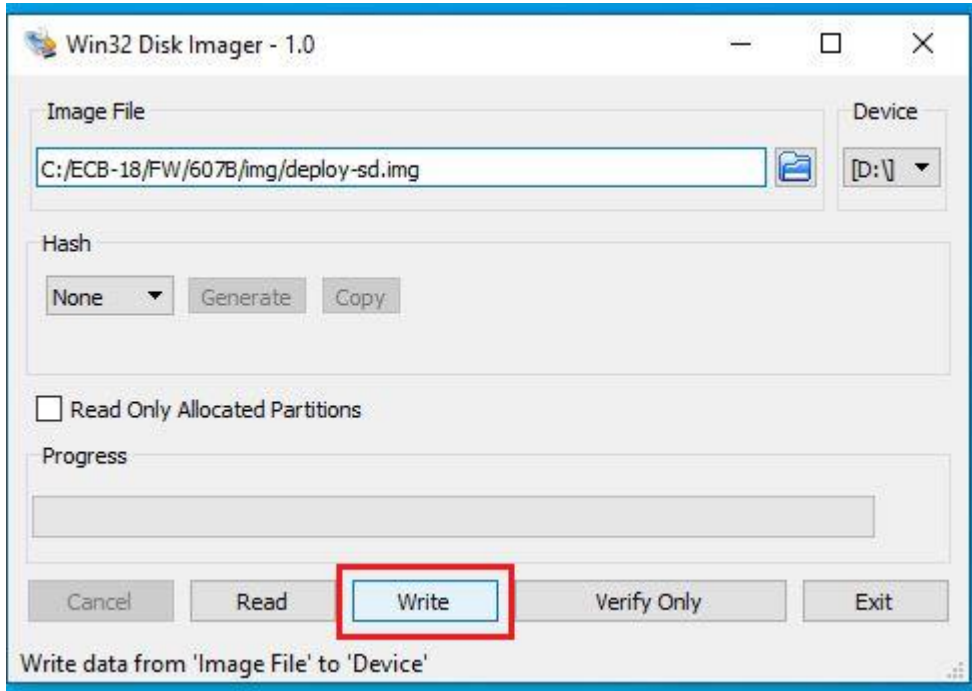


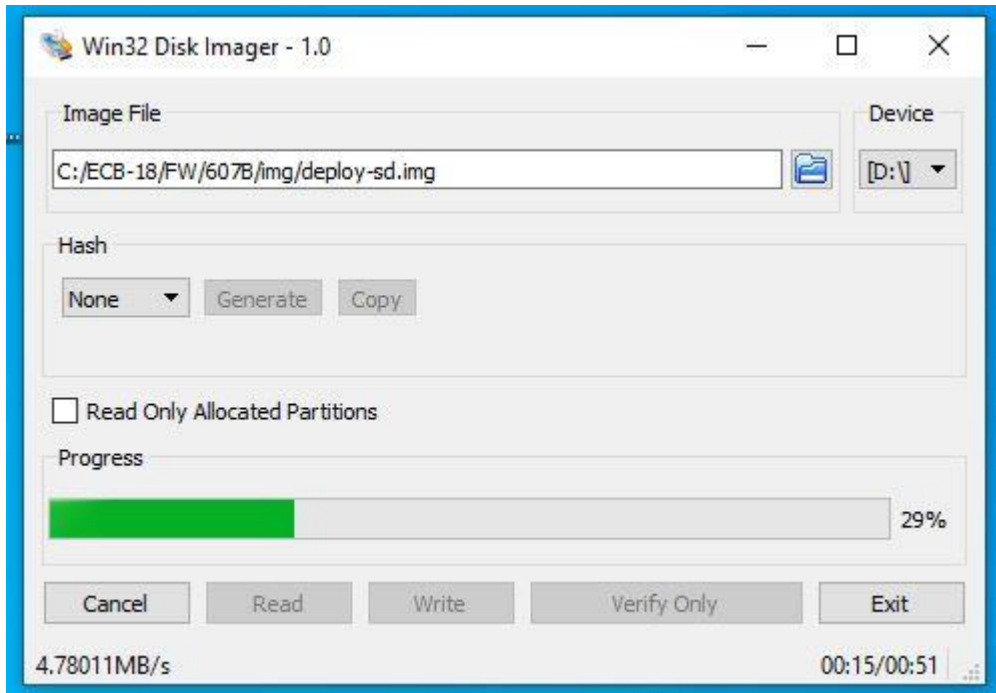
- 4) If there is more than one “USB Driver”, it means that eMMC is connected.
- 5) Run “Win32diskimager” APP



- 6) Select source file: “ /FW/6XXB/img/deploy-sd.img ”





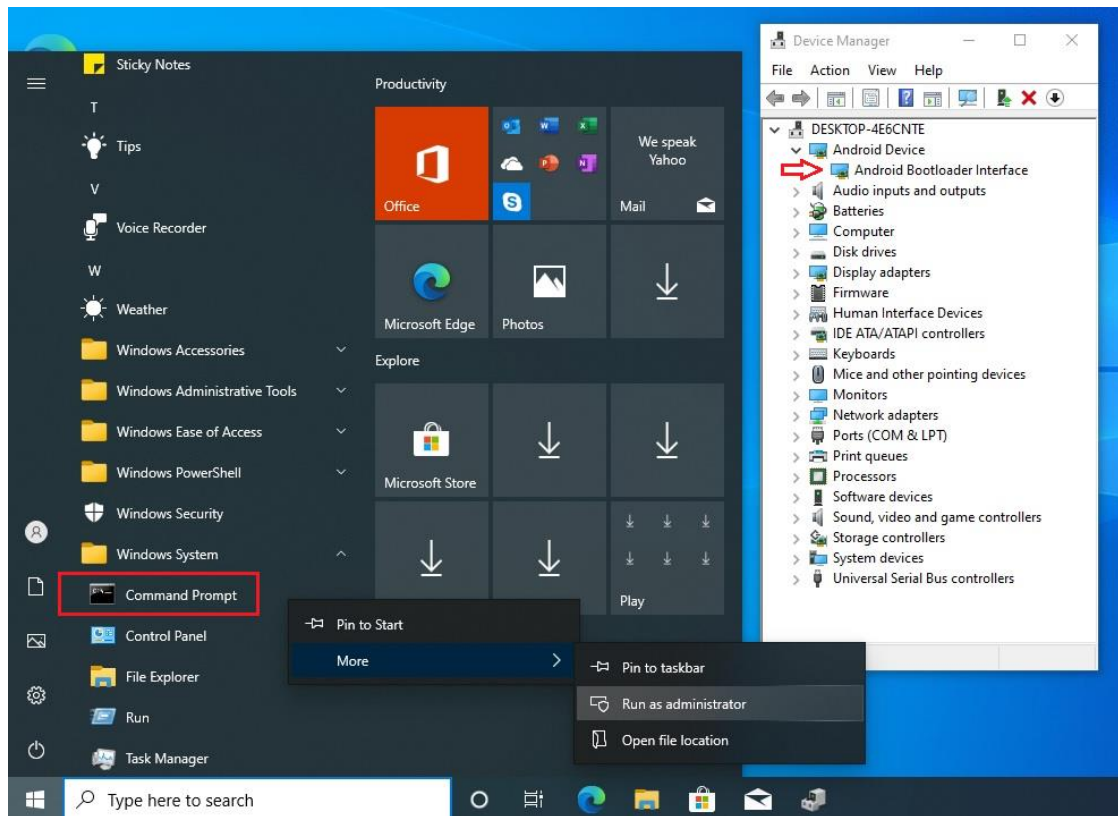


7) Power Off, then change Dip-Switch 2 to **Off** (Normal Mode)

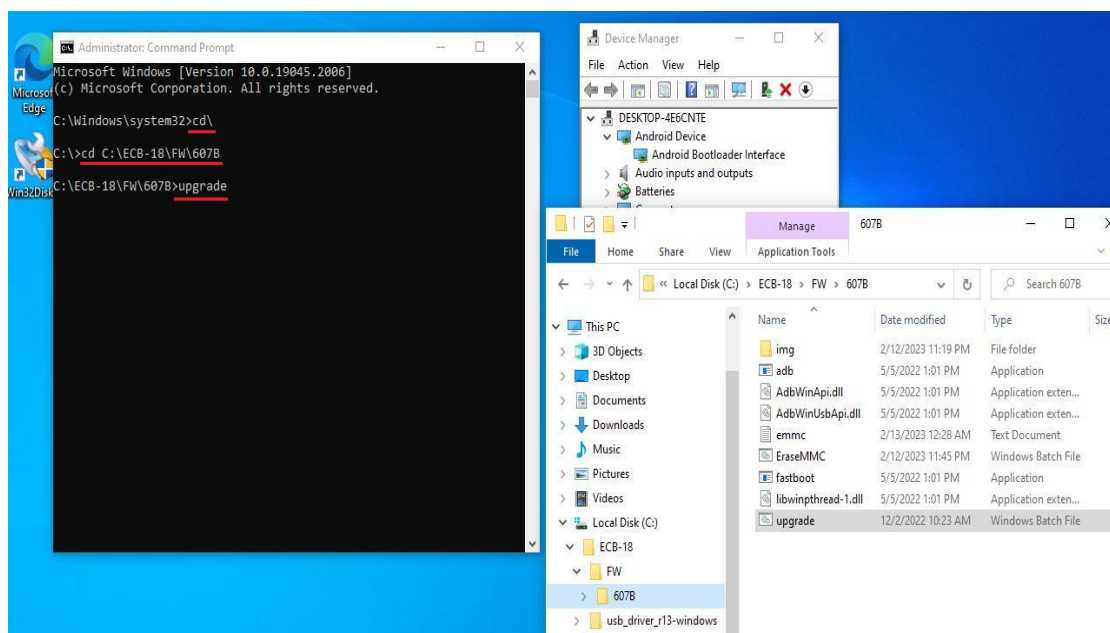


Step 6. → FW image files (Upgrade Android FW)

- 1) Connect Micro USB Cable from ARMPAC-607BP/610BP to your desktop/laptop.
- 2) Power on ARMPAC-607BP/610BP.
- 3) Run “Command Prompt”



- 4) Change the path to the FW placement directory
- 5) Key-in “upgrade.bat”



```
Administrator: Command Prompt - upgrade
Microsoft Windows [Version 10.0.19045.2006]
(c) Microsoft Corporation. All rights reserved.

C:\Windows\system32>cd\
C:\>cd C:\ECB-18\FW\607B
C:\ECB-18\FW\607B>upgrade

C:\ECB-18\FW\607B>fastboot.exe flash gpt .\img\deploy-gpt.img
Sending 'gpt' (128 KB) OKAY [ 0.016s]
Writing 'gpt' OKAY [ 0.031s]
Finished. Total time: 0.094s

C:\ECB-18\FW\607B>fastboot.exe flash bootloader .\img\bootloader-sd.img
Invalid sparse file format at header magic
Sending sparse 'bootloader' 1/1 (7296 KB) OKAY [ 0.266s]
Writing 'bootloader' OKAY [ 6.843s]
Finished. Total time: 7.343s

C:\ECB-18\FW\607B>fastboot.exe flash uboot-env .\img\env.img
Sending 'uboot-env' (256 KB) OKAY [ 0.016s]
Writing 'uboot-env' OKAY [ 0.031s]
Finished. Total time: 0.078s

C:\ECB-18\FW\607B>fastboot.exe reboot
Rebooting OKAY [ 0.000s]
Finished. Total time: 0.000s

C:\ECB-18\FW\607B>timeout /t 3

Waiting for 0 seconds, press a key to continue ...

C:\ECB-18\FW\607B>fastboot.exe oem format
< waiting for any device >
OKAY [ 0.016s]
Finished. Total time: 0.016s

C:\ECB-18\FW\607B>fastboot.exe flash bootloader .\img\bootloader-sd.img
Invalid sparse file format at header magic
```

```
Administrator: Command Prompt - upgrade
< waiting for any device >
OKAY [ 0.016s]
Finished. Total time: 0.016s

C:\ECB-18\FW\607B>fastboot.exe flash bootloader .\img\bootloader-sd.img
Invalid sparse file format at header magic
Sending sparse 'bootloader' 1/1 (7296 KB) OKAY [ 0.249s]
Writing 'bootloader' OKAY [ 6.827s]
Finished. Total time: 7.387s

C:\ECB-18\FW\607B>fastboot.exe flash uboot-env .\img\env.img
Sending 'uboot-env' (256 KB) OKAY [ 0.016s]
Writing 'uboot-env' OKAY [ 0.031s]
Finished. Total time: 0.125s

C:\ECB-18\FW\607B>fastboot.exe flash recovery_boot .\img\boot.img
Invalid sparse file format at header magic
Sending sparse 'recovery_boot' 1/2 (16380 KB) OKAY [ 0.547s]
Writing 'recovery_boot' OKAY [ 0.734s]
Sending sparse 'recovery_boot' 2/2 (7140 KB) OKAY [ 0.234s]
Writing 'recovery_boot' OKAY [ 0.609s]
Finished. Total time: 2.297s

C:\ECB-18\FW\607B>fastboot.exe erase misc
Erasing 'misc' OKAY [ 0.031s]
Finished. Total time: 0.141s

C:\ECB-18\FW\607B>fastboot.exe reboot-fastboot
Rebooting into fastboot OKAY [ 0.047s]
< waiting for any device >
Finished. Total time: 13.374s

C:\ECB-18\FW\607B>fastboot.exe flash boot_a .\img\boot.img
Sending 'boot_a' (32768 KB) OKAY [ 1.111s]
Writing 'boot_a' OKAY [ 0.578s]
Finished. Total time: 2.541s

C:\ECB-18\FW\607B>fastboot.exe flash dtbo_a .\img\boot_dtbo.img
Sending 'dtbo_a' (48 KB) OKAY [ 0.000s]
Writing 'dtbo_a' OKAY [ 0.063s]
```

Please any key to Countinue.....

```
Administrator: Command Prompt
Sending 'dtbo_a' (48 KB) OKAY [ 0.000s]
Writing 'dtbo_a' OKAY [ 0.063s]
Finished. Total time: 0.094s

C:\ECB-18\FW\607B>fastboot.exe flash super .\img\super.img
Invalid sparse file format at header magic
Sending sparse 'super' 1/6 (262124 KB) OKAY [ 13.765s]
Writing 'super' OKAY [ 4.547s]
Sending sparse 'super' 2/6 (262128 KB) OKAY [ 12.905s]
Writing 'super' OKAY [ 4.578s]
Sending sparse 'super' 3/6 (262140 KB) OKAY [ 11.077s]
Writing 'super' OKAY [ 5.906s]
Sending sparse 'super' 4/6 (260588 KB) OKAY [ 12.733s]
Writing 'super' OKAY [ 5.968s]
Sending sparse 'super' 5/6 (235248 KB) OKAY [ 11.390s]
Writing 'super' OKAY [ 5.328s]
Sending sparse 'super' 6/6 (76640 KB) OKAY [ 3.600s]
Writing 'super' OKAY [ 3.390s]
Finished. Total time: 100.759s

C:\ECB-18\FW\607B>fastboot.exe -w
Erasing 'userdata' OKAY [ 0.531s]
Erase successful, but not automatically formatting.
File system type raw not supported.
Erasing 'metadata' OKAY [ 0.000s]
Erase successful, but not automatically formatting.
File system type raw not supported.
Finished. Total time: 0.594s

C:\ECB-18\FW\607B>timeout /t 1

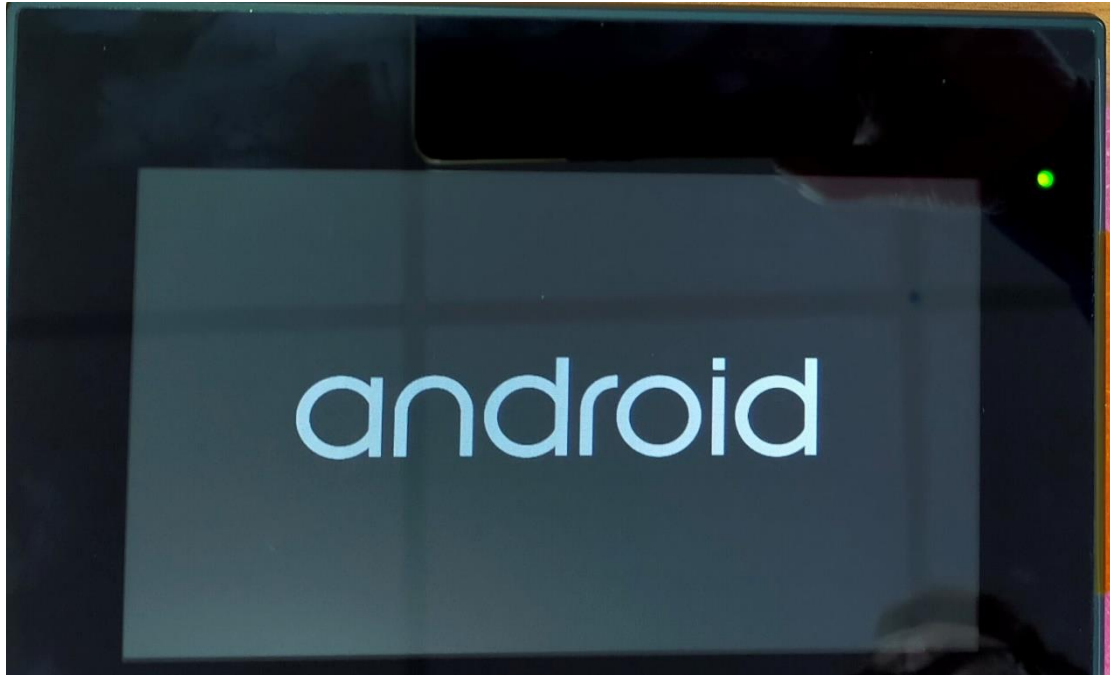
Waiting for 0 seconds, press a key to continue ...

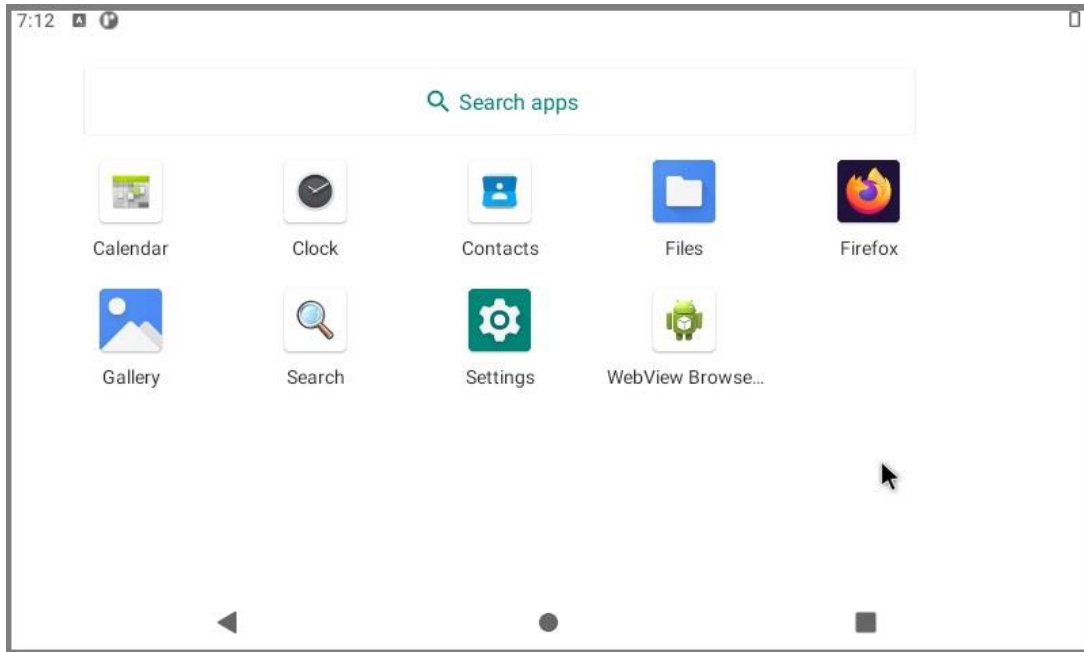
C:\ECB-18\FW\607B>fastboot.exe reboot
Rebooting OKAY [ 0.000s]
Finished. Total time: 0.016s

C:\ECB-18\FW\607B>pause
Press any key to continue . . .

C:\ECB-18\FW\607B>cd..
C:\ECB-18\FW>
```

- 6) When firmware has been updated successfully, The screen will show the “android” word and enter to Android OS desktop.





7) Please remove Micro USB Cable from ARMPAC-607BP/610BP.

Notes:

USB Download Port: When connecting this product to the HOST PC by a micro-USB cable, the USB HUB will be disabled, so these 3 USB host connectors TYPE-A (USB1), Touch (USB3) and m-PCIE 4G/LTE module (USB2) will not work.

Download Tools info:

Download “**rpiboot_setup.exe**”

https://github.com/raspberrypi/usbboot/raw/master/win32/rpiboot_setup.exe

Download “**win32diskimager-1.0.0-install.exe**”

https://osdn.net/projects/sfnet_win32diskimager/downloads/Archive/win32diskimager-1.0.0-install.exe/

Download the “**Google USB Driver ZIP File**” (usb_driver_r13-windows.zip)

<https://developer.android.com/studio/run/win-usb>

